# TIBERCAD User Manual

Fabio Sacconi, Matthias Auf der Maur, Michael Povolotskyi, Giuseppe Romano, Alessandro Pecchia, Gabriele Penazzi, Stefano Bellocchio, Aldo Di Carlo

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TIBERCAD User Manual

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# Installation instructions

In the following, VERSION denotes the version number of the TIBERCAD release you downloaded and INSTALLPATH denotes the directory where TIBERCAD gets installed. Version 2.3.0 of GMSH (http://www.geuz.org/gmsh) will be installed together with TIBERCAD. For the Linux version of GMSH you need OpenGL libraries installed on your system.

## Prerequisites

Get the installer package for your OS/architecture from http://www.tibercad.org or by contacting support@tibercad.org. Table 1 lists the packages available for download. To run TIBERCAD you will also need a license file that you will have to copy into the installation directory of TIBERCAD.

In the Windows version, some graphical features such as graphical convergence monitors are only available if an X Window server is installed and running.

## Windows installation procedure

To install TIBERCAD in Windows, run the setup program tibercad-version\_setup.exe. During the installation you can choose the installation directory. After finishing installation, copy your license file (tibercad.lic) into the license subdirectory of the TIBERCAD installation directory (INSTALLPATH/license), without changing its filename.

installer package name	Target architecture					
$tibercad-version\_setup.exe$	Windows 32-bit					
tibercad-version_installer.bin	Linux 32-bit self-extracting installer					

 Table 1: Installer packages

## Linux installation procedure

To install TIBERCAD in Linux, download and run the self-extracting installer tibercadversion\_installer.bin and follow the installation instructions.

After installation, copy your license file (tibercad.lic) into the 'license' subdirectory of the TIBERCAD installation directory (INSTALLPATH/license) without changing the filename. You can also provide the license file during installation.

The standard method to launch TIBERCAD is by means of a shell script that is installed alongside the TiberCAD executable. It takes care of setting all necessary environment variables. If for some reason you have to run the executable directly, remember to set TIBERCADROOT to the TiberCAD installation directory (INSTALLPATH).

## Quick start guide

In the 'examples' subdirectory you can find several examples ready to run. They are the same as the tutorials on http://www.tibercad.org/documentation/tutorial/list.

### Windows

Open Windows Explorer and go to the TIBERCAD installation directory. If you have write permission in the installation directory, you can browse to an examples directory and start the simulation by double clicking the input file, e.g. bulk.tib in Example\_0. If not, copy the whole directory to a location in your personal area and run the examples from there.

If you cannot run TIBERCAD by double clicking an input file (\*.tib), then the input files are probably not correctly associated with the TIBERCAD executable. In this case, try to establish the association by right-clicking the input file, choosing open with...  $\rightarrow$  Choose Program...  $\rightarrow$  Browse..., browsing to the TIBERCAD installation directory and choosing the TIBERCAD executable, tibercad.exe. A directory containing the simulation results will be created with the name provided in the input file.

#### Linux

After the correct installation of TIBERCAD you should be able to run TIBERCAD from the command line using the command tibercad. If not, you probably have to add the bin subdirectory of the TIBERCAD installation directory to your PATH environment variable or start the TIBERCAD executable using the absolute path (INSTALLPATH/bin/tibercad). Copy the directory of the example you want to run, e.g. bulk\_Si, to your home directory or any place you have write permissions for. Change to the newly created directory and run TIBERCAD by (assuming Example\_0)

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```
$ tibercad bulk.tib
```

A directory containing the simulation results will be created with the name provided in the input file.

# Bug reports / Feedback

Please send bug reports, feedback or suggestions to support@tibercad.org. When submitting bug reports, please always include the full version number of TIBERCAD you are running. The full version number appears in the first line of output when running the program:

```
$ tibercad
```

```
TiberCAD version 1.0.0-961
```

```
Usage: tibercad <inputfile>
```

# Chapter 1

# Overview

## 1.1 Intoduction to numerical simulation with Tiber-CAD

TiberCAD is a multiphysics software tool; it comprises a set of solvers, called simulation models, each one describing a physical problem to be solved, e.g. DriftDiffusion (to solve Poisson and DriftDiffusion equations), EFASchroedinger (to solve Schroedinger equation in envelope function approximation), Macrostrain (to calculate macroscopical strain with an elastic model) and others.

Similarly to other device CADs, TiberCAD requires that one follows a three-step procedure.

In a first step the device geometry must be sketched, giving all the geometrical information needed by the simulations. This can be performed by means of a text file or with the help of a graphical tool. During this procedure one or more *mesh regions* and *boundary regions* have to be defined: in a following stage the *mesh regions* will be associated to materials and *boundary regions* to device contacts (boundary conditions in general).

The second step consists in running a *mesher* tool, which reads the geometry file and sets up the computational mesh used to discretize the partial differential equations representing the physical models to be solved. For this procedure TIBERCADmakes use of the GPL software *gmsh*. Optionally, mesh outout provided by other meshers, such as the one included in ISE-TCAD tool, are also supported. The output of the meshing procedure is a mesh file that contains information about the space discretization as well as the *mesh regions* and the *boundary regions*.

In the last step the actual simulations are performed. Together with the mesh information (comprised in the mesh file ), TiberCAD requires an input file which associates *materials* to *mesh regions*, defines the physical properties and physical models to be applied, and the type of calculations to be performed.

Details about the modeler and mesher tools can be found in the specific user-manuals. Here we deal primarily with the TiberCAD input file. However, in discussing examples of 1D, 2D and 3D simulations, we will also describe in some detail the geometry input files used to run *gmsh*.

#### **1.1.1** Input file structure

TiberCAD input file is a text file which includes a description of the device structure, the definition of the solvers to be executed, with all the relevant physical and numerical parameters for each of them.

The input file is organized into several sections, each describing a different aspect of the problem to be solved. The strategy employed is similar to other commercial T-CAD tools and requires some practice to reach a good level of familiarity. We strongly suggest to read first the following chapters (Getting Started 1 and 2) in this manual and then study the input files provided in the examples directory and try to modify them, before writing your own input file from scratch. The example files touch all current features implemented in the code.

Let's see an overview of the main features of the input file The core of the input file comprises three sections, called **Device**, **Models** and **Simulation**:

```
$Device
{
Region Si_channel
{
material= Si
doping = 1e16
}
Region gate_oxide
{
material= SiO2
}
....
}
$Models
{
```

```
model driftdiffusion
{
    simulation_name= dd
}
....
}
$Simulation
{
    solve= dd
}
```

The section **Device** is used to associate one or more mesh regions to a material and to a set of physiscal properties such as doping concentrations, doping levels, etc. The section **Model** is used to define the physical models to be solved. Each physical model can be applied to the whole device, or to a set of regions of the device, (defined in **Device** section). Finally, **Simulation** section states the type of calculation to be executed, that is the *simulation* to be *solved*. These sections will be described in full details in the following.

Besides these main sections, there other other two, called **Solver** and **Physics**, where some parameters can be set, respectively for the numerical solvers and for the physical models. The aim of these sections is to give the user the maximum of flexibility to tune his/her simulation. Especially regarding the Solver case, values of the numerical parameters have been already tuned for each application and should be modified only by an advanced user.

# 1.2 Definition of physical and boundary regions in TiberCAD

Let'see now in more detail how to associate *physical* information to the regions of the device model and how to define the boundary regions, that is contacts or, in general, regions where some kind of boundary condition is to be applied.

When TIBERCAD is run, it reads the mesh file which contains the finite element grid which meshes the geometrical description of the device or nanostructure, and which will be the basis of PDE discretization.

As we have seen before, to execute the proper simulations, TIBERCAD needs some information about the physical and boundary regions associated with the mesh. A physical region associates all the elements corresponding to an homogeneous part of the device (usually related to the same material or doping). In TIBERCAD, these regions are referred to as **mesh\_regions**.

As for boundary regions, they are needed to specify boundary conditions (b.c.) for the solution of the PDEs of our simulation. By default, to all the external boundary of the device a Neumann b.c. is imposed, meaning null derivative of electric field and zero flux of current normal to the boundary. These are the usual b.c. applied in the simulation of electronic devices; in particular, these conditions are implicitly satisfied by using the finite element formulation. Usually, however, one needs to impose also specifical b.c. to the device, relative, most often, to contacts of some kind (ohmic, schottky), but also heat and temperature b.c. or reference substrates for strain calculations. These regions, (constituted by surfaces, lines or points, respectively for 3D, 2D and 1D simulations) are called in TIBERCAD **boundary regions**.

It is important to know that the information about the physical and boundary regions must be present in the mesh file before it is read by TIBERCAD, and thus have to be produced by making use of the modeling/mesher software. As for now, TIBERCAD supports the mesh output of the following software tools: **GMSH v.2** and **ISE-TCAD v.9.5**.

#### 1.2.1 Using ISE-TCAD

By means of the utility DEVISE of ISE-TCAD v.9.5, it is possible to design and mesh a device; after the meshing has been successfully performed, an output file is produced, with the extension *.grd*. This file contains the description of the mesh and also the list of the user defined material regions and contact regions. By reading this *.grd* file in TIBERCAD, one can refer to the ISE TCAD material regions, simply with the userdefined name, which is present in the *.grd* file. This name should be unique in the whole device. In the same way, ISE TCAD Boundary regions (*Contacts*) can be referred to in TIBERCAD by means of their user-defined name, present in the *.grd* output file, too.

#### 1.2.2 Using GMSH

If GMSH program is used to model and mesh the device, a bit more care has to be taken. Here we introduce the procedure to be followed; in the following tutorials (Getting started... the subject will be considered in detail with a step-by-step description. See also the GMSH user manual (http://geuz.org/gmsh) for further details.

In the context of GMSH, it is possible to define several 1, 2 and 3D *Physical Entities*. These *Physical Entities* allow to associate one or more geometrical entities to a single numerical ID or, better, to a string label, so that several **mesh\_regions** and **boundary**  **regions** can be defined and referred to by TiberCAD. Here is a simple example of a script to generate a 1D geometrical model (\*.geo) file in GMSH: (see also chapter 2)

```
Point(1) = {-25,0,0,0.5};
Point(2) = {0,0,0,0.002};
Point(3) = {25,0,0,0.5};
Line(1) = {1,2};
Line(2) = {2,3};
```

```
Physical Line("p_side") = {2};
Physical Line("n_side") = {1};
Physical Point("cathode") = {3};
Physical Point("anode") = {1};
```

Here, first the geometrical entities **Points** and **Lines** are defined.

In the definition of the geometrical **Points**, the three first expressions inside the braces on the right hand side give the three X, Y and Z coordinates of the point ; the last expression (0.5 or 0.002 in this example) sets the **characteristic mesh length** at that point, that is the **size** of a mesh element, defined as the length of the segment for a line mesh element, the radius of the circumscribed circle for a triangle mesh element and the radius of the circumscribed sphere for a tetrahedron mesh element. Thus, the smaller is the value of the **characteristic mesh length**, the greater is the mesh density close to that point. The size of the mesh elements will then be computed in GMSH by linearly interpolating these characteristic lengths in the whole mesh.

In the definition of a geometrical **Line**, the two expressions inside the braces on the right hand side give the identification numbers of the start and end **Points** of the line.

Then, two physical regions are defined, each associated to one of the two geometrical entities: **Physical Line(n\_side)** and **Physical Line(p\_side)**. The expression(s) inside the braces on the right hand side give, in general, the identification numbers of all the geometrical lines that need to be grouped inside the **Physical Line**.

In this way, these physical regions are made available for TIBERCAD, and will be used to associate them to a TIBERCAD region through the keyword **Region**, as follows:

Region n\_side
{
.....

Region p\_side

```
{
```

. . . . . . . . . . .

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It is also possible to group more than one physical region in a single Device Region, with the keyword **mesh\_regions**, as follows:

```
Region reg_1
{
    mesh_regions = (region1, region2)
....
Region reg_2
{
    mesh_regions = (region3, region4)
```

. . . . . . . . . . .

Note that, in this case, *region1*, *region2*, *region3*, *region4* are the labels previously defined inside GMSH, while *reg\_1* and *reg\_2* are names chosen by user for his convenience.

Then, in the GMSH script, two **Physical Point** are defined, **anode** and **cathode**, and associated to the first and to the last point of our 1D device. These points are needed to impose some boundary conditions and in this way they are made available for TiberCAD, and will be used to associate each of them to a boundary condition region, through the keyword **BC\_Region**:

BC\_Regions

{
 BC\_Region cathode
 {
 .....
BC\_Region anode
 {
 .....

#### 1.3. SIMULATION ENVIRONMENTS

As before, it is possible group more boundary regions in a single **BC\_Region**, with the keyword **BC\_reg\_numb** 

```
BC_Regions
{
    BC_Region cathode
    {
        BC_reg_numb = (contact1, contact2)
.....
```

Again, in this second case, *cathode* is a label chosen by user, while *contact1* and *contact2* are labels previously defined inside GMSH.

In 2D case, a set of **Physical Surface** will be defined to be used as **mesh\_regions**, while **Physical Line** is used for **boundary regions**.

Finally, in 3D case, **Physical Volume** is used to define **mesh\_regions**, while **Physical Surface** is used to define **boundary regions**.

### **1.3** Simulation environments

TIBERCAD allows to compute different physical models in different parts of a device or nanostructure by coupling in a general way different *simulation environments*. A *simulation environment* is composed by all the physical regions to which a particular model is assigned. A *simulation environment* is therefore defined by the mesh elements belonging to its physical regions and by the **simulation model** which has been associated to these regions. This association is made possible by the definition of TIBERCAD **Regions** and **Clusters**. Different *simulation environments* can have physical regions in common. In this way, each simulation is run on a subset of the device and can be possibly coupled (even self-consistently) with a simulation run on a different subset of the device corresponding to a *simulation environment* with a non-void intersection with the first one. The coupling of the two simulations is performed by means of appropriate Boundary Conditions (e.g. Current Density, Voltage, ...). In principle, the two *simulation environments* can refer to two simulations at different scale, e.g. atomistic tight-binding and macroscopic drift-diffusion. This allows an effective **multi-scale** simulation of the device to be studied.

# Chapter 2

# Getting started 1D

In this section we will see, step by step, how to use TIBERCAD to simulate numerically a semiconductor device. As a very simple example we will refer to the **Tutorial 0** (Si bulk) that you can find in the *Tutorials* directory.

### Step 1: Modeling the device

As a first step, we have to model the device. To do so, you can use DEVISE module of ISE-TCAD 9.5 software package or GMSH program. Here we'll see in details the procedure for GMSH. There are two possible ways to use GMSH:

1. Interactive, using the graphical interface

2. Using a script file.

In the following we'll see how to write a basic GMSH script (bulk.geo); for any details please refer to GMSH manual GMSH (http://geuz.org/gmsh/).

In a GMSH script, several variables can be defined and given a value in this way:

L = 1; d = 0.01;

these are valid GMSH variables: L is just the length of the Si sample; d is the value of a **characteristic mesh length** (see below).

• Definition of geometrical entities **Points**:

Point(1) = {0, 0, 0, d}; Point(2) = {L, 0, 0, d}; In the definition of a geometrical point, the three first expressions inside the braces on the right hand side give the three X, Y and Z coordinates of the point; the last expression (d) sets the **characteristic mesh length** at that point, that is the **size** of a mesh element, defined as the length of the segment for a line mesh element, the radius of the circumscribed circle for a triangle mesh element and the radius of the circumscribed sphere for a tetrahedron mesh element.

Thus, the smaller is the value of d, the greater is the mesh density close to that point. The size of the mesh elements will then be computed in GMSH by linearly interpolating these characteristic lengths in the whole mesh.

**N.B.**: In a 1D simulation it is assumed that the geometrical model is restricted to the x axis. Any other geometrical orientation could give impredictable results.

• Definition of geometrical entity Line:

Line(1) =  $\{1, 2\};$ 

The two expressions inside the braces on the right hand side give the identification numbers of the start and end points of the line.

• Definition of the physical entity **Physical Line 1**:

Physical Line(1) = {1};

The expression(s) inside the braces on the right hand side give the identification numbers of all the geometrical lines that need to be grouped inside the **physical line**. In this way, in general, **physical regions** are created which associate together geometrical regions, and then the related mesh elements, which share some common physical properties. It's only these physical regions which can be referred to outside GMSH. In TIBERCAD, this is done by associating one or more physical regions to a **TiberCAD region** through the keyword **mesh\_regions** (see in the following).

• Definition of two physical entities **Physical Point**:

Physical Point(1) = {1}; Physical Point(2) = {2};

Beginning from GMSH v.2, it is possible, alternatively, to assign more convenient **Physical Names** to the Physical entities, instead of numerical IDs. **Physical Names** consist of strings enclosed between quotation marks. The syntax is the following:

```
Physical Line("bulk") = {1}
....
Physical Point("Anode") = {1};
```

**N.B.**: In general, in a n-Dimension (nD) simulation, (n-1)D physical regions (points in 1D, lines in 2D, surfaces in 3D) are used by TIBERCAD to impose the required boundary conditions. Each (n-1)D physical region defined in this way in GMSH will be associated in TIBERCAD to a boundary condition region, through the keyword **BC\_reg\_numb**. Thus, in this case, Physical points 1 and 2 will be associated respectively to two BC regions (see in the following).

## Step 2: Meshing the device

The *.geo* script file with the geometrical description can be run in GMSH, to display the modelled device and to mesh it through the GMSH graphical interface. Alternatively, a *non-interactive* mode is also available in GMSH, without graphical user interface. For example, to mesh this 1D tutorial in non-interactive mode, just type:

gmsh bulk.geo -1 -o bulk.msh

where *bulk.geo* is the geometrical description of the device with GMSH syntax; -1 means 1D mesh generation;

some command line options are:

-1, -2, -3 to perform 1D, 2D or 3D mesh generation,

-o mesh\_file.msh to specify the name of the mesh file to be generated

In this way, a .msh has been generated and is ready to be read in TIBERCAD.

## Step 3: TiberCAD Input file

Now we have to write down the TIBERCAD input file (see *bulk.tib* in the Tutorials).

#### 1 - Definition of Device Regions

First, we have to list all the TIBERCAD Regions present in our device: a TIBERCAD **Region** is usually a somehow physically homogeneous region of the device or the nanostructure we are going to model, featuring the same material and possibly the same doping.

```
$Device
{
Region bulk
```

```
{
mesh_regions = 1
material = Si
doping = 1e16 doping_type = donor
}
```

}

In this example, the TIBERCAD **Region** bulk is made of Silicon and n-doped with a concentration  $10^{16} cm^{-3}$ .

Through the keyword **mesh\_regions**, one or more of the *physical regions* (*Physical Lines* in 1D, *Physical Surfaces* in 2D, *Physical Volumes* in 3D) previously defined in the GMSH mesh can be associated to the present TIBERCAD **Region**.

With  $mesh\_regions = 1$ , we associate the Physical Line 1, defined in the Step 1, to the TIBERCAD Region bulk.

### **2** - Definition of Simulation

Now we define the **Simulation** *driftdiffusion\_1*: it belongs to the class **driftdiffusion** 

```
Models
{
model driftdiffusion
{
options
{
simulation_name = driftdiffusion_1
physical_regions = all
}
```

The TIBERCAD simulation  $drift diffusion_1$ , belonging to the model drift diffusion, will be applied to the whole device structure (*physical\_regions = all*).

### **3** - Definition of Boundary Conditions

The anode and cathode contacts of our 1D Si sample are defined as **Boundary condi**tions regions (*BC\_Region anode, BC\_Region cathode*) in the following way:

```
BC_Region anode
{
BC_reg_numb = 1
```

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```
type = ohmic
voltage = @Vb
}
BC_Region cathode
{
BC_reg_numb = 2
type = ohmic
voltage = 0.0
}
```

Both contacts are defined as *ohmic*, cathod is assigned a fixed *voltage* = 0.0, while anode voltage is given by the value of the variable Vb (*voltage* = @Vb).

Through the keyword **BC\_reg\_numb**, one or more of the (n-1)-Dimension physical regions (Physical Points in 1D, Physical Lines in 2D, Physical Surfaces in 3D) previously defined in the GMSH mesh can be associated to the present TIBERCAD **BC Region**. With  $BC\_reg\_numb = 1$ , we associate the Physical Point 1, defined in the **Step 1**, to the TIBERCAD **BC Region** anode; with  $BC\_reg\_numb = 2$ , we associate the Physical Point 2, defined in the **Step 1**, to the TIBERCAD **BC Region** cathode.

Alternatively, one can make use of the **physical names** associated to the physical regions in the meshing tool. In this case, we simply associate the **(n-1)D** physical region, respectively "anode" and "cathode", by means of the TIBERCAD BC Region name:

```
BC_Region anode
{
  type = ohmic
  voltage = @Vb
}
BC_Region cathode
{
  type = ohmic
  voltage = 0.0
}
```

Note that, in this case, the TIBERCAD BC Region name needs to be identical to one of the physical names defined during the modeling of the device with GMSH.

#### 4 - Definition of Simulation parameters

The variable Vb is specified in the *sweep* block, in the **Solver** section

```
sweep
{
  simulation = driftdiffusion_1
  variable = Vb
  start = 0.0
  stop = 1
  steps = 10
}
```

In this way, the simulation  $drift diffusion_1$  is performed for 10 (steps = 10) values of the anode voltage (variable = Vb), between 0 and 1.

#### **5** - Definition of Execution parameters

In the **Simulation** section, we decide *which* simulations to perform and in which *order*; we set *solve* = *sweep*, to execute the *sweep* which run *driftdiffusion\_1* simulation for the specified loop.

```
$Simulation
{
#searchpath = .
meshfile = bulk.msh
dimension = 1
temperature = 300
solve = sweep
resultpath = output
output_format = grace
plot = (Ec, Ev, ContactCurrents)
}
```

Output files with conduction and valence band profiles (plot = Ec, Ev.) and all the calculated values of the current at the contacts (*ContactCurrents*) (the IV characteristic) are generated.

## Step 4: Run TiberCAD

Now we can run TiberCAD:

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tibercad bulk.tib

The generated **Output** files are:

driftdiffusion\_materials.dat: material (mesh) regions, in this case just region 1 driftdiffusion\_nodal.dat: nodal quantities (here conduction and valence band) sweep\_driftdiffusion\_Vb.dat : integrated current at the two contacts for each sweep step.

# Chapter 3

# Getting started 2D

In this second example we will refer to the **Tutorial 4** (Si n-Mosfet) that you can find in the *Tutorials* directory.

# Step 1: Modeling the device

Again, as a first step, we have to model the device.

We'll see in some details how to design and mesh a mosfet device with GMSH.

• In the GMSH script *mosfet.geo* , several variables are defined and given a value in this way:

lsub=0.03; lacc=0.002; lct=0.0005; lg=0.0015; lh=0.01; lc=0.0005;

these variables are used in the script to assign proper values to the **mesh charac**teristic lengh of the defined Points

Lg\_2 = 0.0375; d = 0.01; Ls = 0.1; h = 0.25; b = 0.0025; o = 0.005; xd = Lg\_2 + d; xd2 = Lg\_2 + d / 2; xmax = xd + Ls - d;

These other convenient variables are used to parametrize the most relevant geometrical features, such as channel length, oxide thickness, and so on.

• Geometrical **Points** and **Lines** are defined to design the device structure; the fourth parameter in **Point** assignment is the characteristic length associated to that point: this is an essential feature to control the mesh density and refine it where necessary (usually n the channel region).

**N.B.**: In a 2D simulation it is assumed that the geometrical model is restricted to the xy-plane (z = 0). Any other geometrical orientation could give impredictable results.

```
Point(1) = {0, -h, 0, lsub};
Point(2) = \{0, 0, 0, 1c\};
Point(3) = \{xmax, -h, 0.0, 1sub\};
Point(4) = \{-xmax, -h, 0.0, lsub\};
Point(5) = \{xmax, 0, 0.0, lh\};
Point(6) = \{-xmax, 0, 0.0, lh\};
Line(1) = \{4,1\};
Line(2) = \{3, 13\};
Line(6) = \{4, 14\};
Line(7) = \{10, 9\};
Line(8) = \{12, 2\};
Line(9) = \{8,7\};
Line(10) = \{11, 8\};
Line(11) = \{9, 12\};
Line(13) = \{7, 6\};
```

• Definition of a surface: first a **line loop** is composed, listing all the lines constituting the boundary of the surface; then this line loop is assigned to a **Plane Surface** object (this procedure can be alternatively performed through the graphical interface).

Line Loop(40) = {28,2,-34,33,8,29,-31,-30,-6,1}; Plane Surface(41) = {40};

• Definition of the **Physical surfaces** : each of them is composed by one or more geometrical **Plane Surface**. For example, **Physical surface** 2 comprises the two separated contact regions, while **Physical surface** 3 corresponds to the oxide region.

The **Physical surfaces** are the 2D Physical regions of the mesh and will be assigned to the related TIBERCAD regions through the keyword *mesh\_regions* (see Step )

```
Physical Surface(1) = {41}; // n-Si
Physical Surface(2) = {44,47}; // n+-Si
Physical Surface(3) = {46}; // SiO2
```

• Definition of the **Phisical Lines**: In this 2D simulation, 1D physical regions are used to carry information about boundary condition regions. In other word, each **Phisical Line** corresponds to a boundary condition (a contact in the case of a driftdiffusion calculation): thus Physical Line 1 refers to source contact, P.L. 2 to gate contact, P.L. 3 to drain contact. The numerical identifications of these **Phisical Lines** will be asigned to TIBERCAD **BC regions** by means of the *BC\_reg\_numb* instruction.

```
Physical Line(1) = {13}; // source
Physical Line(2) = {39,38}; // gate
Physical Line(3) = {19}; // drain
```

In fig. 3.1 the obtained geometrical model is shown.

### Step 2: Meshing the device

The *.geo* script file with the geometrical description can be run in GMSH, to display the modelled device and to mesh it through the GMSH graphical interface (see fig. 3.2). Alternatively, a *non-interactive* mode is also available in GMSH, without graphical user interface. For example, to mesh this 2D tutorial in non-interactive mode, just type:

gmsh mosfet.geo -2 -o mosfet.msh

## Step 3: TiberCAD Input file

Now we have to write down the TIBERCAD input file (see *mosfet.tib* in the Tutorials).



Figure 3.1: Geometrical structure as defined by GMSH modeller



Figure 3.2: 2D Mesh for the mosfet device obtained with GMSH

### 1 - Definition of Device Regions

Three TIBERCAD regions are defined: to each of them, one mesh\_region is associated, that is the Phisical Surfaces 1, 2 and 3 defined in Step 1. However, in general more than one mesh\_region can be associate to a single TIBERCAD region, if this is convenient.

```
Region substrate
  {
    mesh_regions = 1
   material = Si
    doping = 1e18 doping_type = acceptor
  }
  Region contact
  ſ
   mesh_regions = 2
    material = Si
    doping = 5e19 doping_type = donor
  }
  Region oxide
  {
   mesh_regions = 3
   material = SiO2
  }
```

### 2 - Definition of Simulation

Now we define the **Simulation** dd: it belongs to the class **driftdiffusion** 

```
model driftdiffusion
{
    options
    {
        simulation_name = dd
        physical_regions = all
    }
```

We declare two driftdiffusion physical models: the first defines a *srh* recombination model (see 6.3.1); the second defines a *field-dependent* mobility model for electrons which implements a *doping dependence* for the low-field mobility (see 6.3.3).

```
physical_model recombination
{
    model = srh
}
physical_model electron_mobility
{
    model = field_dependent
    low_field_model = doping_dependent
}
```

### **3** - Definition of Boundary Conditions

The source, drain and gate contacts of the Mosfet device are defined as **Boundary** conditions regions ( $BC_Region$  source,  $BC_Region$  drain,  $BC_Region$  gate) in the following way:

```
BC_Region gate
{
    BC_reg_numb = 2
    type = schottky
    barrier_height = 3.0
    voltage = @Vg[0.0]
}
BC_Region source
{
    BC_reg_numb = 1
    type = ohmic
```

```
voltage = 0.0
}
BC_Region drain
{
    BC_reg_numb = 3
    type = ohmic
    voltage = @Vd[0.5]
}
```

To each of the **BC regions**, one  $BC\_reg\_numb$  is assigned, that is one of the Physical Lines **1**,**2**, **3** defined in **Step 1**, which represent the contact regions.

Note that, while *source* and *drain* are defined as type = ohmic, gate **BC region** is defined as type = schottky;  $barrier_height = 3.0$  specifies the metal/oxide interface barrier and depends on the contact metal workfunction.

Drain voltage is defined as @Vd[0.5] and gate voltage as @Vg[0.0]. This specifies that the value of the voltage will be determined at each moment of the simulation, by the value of the two variables Vd and Vg, which will be assigned in the **sweep** definition.

### 4 - Definition of Simulation parameters

Two sweeps are requested for this simulation, that is an external loop on Vg (the gate voltage) and an internal loop on Vd (the drain voltage) for each value of Vg; in this way, the IV drain characteristics for a series of gate biases are obtained in output.

```
sweep_1
{
   simulation = dd
   variable = Vd
   start = 0.0
   stop = 2.0 #0.1
   steps = 200 #200 #1
# plot_data = true
}
sweep_2
{
   variable = Vg
```

```
start = -0.1
stop = 0.5
steps = 6
simulation = sweep_1
#simulation = driftdiffusion
}
```

### **5** - Definition of Execution parameters

In the **Simulation** section, we decide the simulation dimension (dimension = 2), then *which* simulations to perform and in which *order*; we set *solve* = *sweep\_2*, to execute the external gate voltage sweep *sweep\_2* which in its turn call the sweep *sweep\_1* where drain current is calculated for all the chosen drain voltage steps by running *dd* **simulation**.

Output files with conduction and valence band profiles, quasi-fermi levels, electron and hole density, recombination, electric field and potential (plot = Ec, Ev, ....) will be generated, together (*ContactCurrents*) with a file with all the calculated values of the drain current at the contacts for each gate bias step (the IV characteristics).

## Step 4: Run TiberCAD

Now we can run TiberCAD: tibercad mosfet.tib

The generated **Output** files are:

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driftdiffusion\_materials.vtk: information about the material regions of the device.

driftdiffusion\_nodal.vtk output for the nodal quantities which have been calculated, e.g. conduction and valence bands, (quasi)fermi levels, electron and hole density and mobility.

driftdiffusion\_elemental.vtk output for the elemental quantities (e.g. electric field, current density).

sweep\_2\_driftdiffusion\_Vg\_0.000\_Vd.dat and similar for all the Vg steps: drain current characteristics for each Vg bias.

# Chapter 4

# Input for TiberCAD

Input for TIBERCAD is composed by an input file e.g. "input.tib" and a mesh file generated by a mesher software: as for now, mesh files from GMSH (\*.msh, v.1 and v.2.0) and from ISE-TCAD (\*.grd) are supported.

Be sure that the material files are in the correct directory (as specified in 4.7). To run the program, type: **tibercad** *input\_file\_name* 

## 4.1 Description of Input file structure

A valid input file for TIBERCAD is a text file with the structure described in the following.

In the whole input file, everything following a '#' is considered as a comment and is disregarded; blank lines can be present anywhere and are disregarded too.

Input file is composed by several **sections**: each **section** begins with a **section-name** preceded by "\$" (e.g. \$Physics).

A section is enclosed between "{" and "}" brackets and is possibly composed (depending on the section) by a variable number of **blocks** enclosed between "{" and "}" brackets.

Each **block** can be possibly composed by one or more blocks, each preceded by a block-name.

The elementary block (**parameters-block**) is a block which contain zero or any number of **parameter assignements** in the form:

"tagname = tagvalue", where

- "tagname" is a string
- "tagvalue" is a single numerical or string item or a list of items between "(" and ")" parenthesis and separated by commas. e.g. (cathode, anode)
Format is free for the parameter assignements, provided that they are separated by spaces. Everything which follows a '#' is considered as a comment and is disregarded. For example:

```
driftdiffusion
{
    coupling = poisson
    nonlin_max_it = 70
    nonlin_rel_tol = 1e-10
    ls_max_step = 2
    ksp_type = bcgs
}
```

Here and in the whole input file a string item can include a combination of characters, special characters and numbers, but not spaces; if a space is found , the string item is taken as terminated.

The input file is composed by the following sections: **Device**, **Scale**, **Models**, **Physics**, **Solver**, **Simulation** which will be described in the following.

# 4.2 Device section

In "**Device**" section, two kinds of block can be present: the **Region** block and the **Cluster** block.

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The **Region** blocks contain the description of the device in continuous media approach; the **Cluster** blocks define each a group of regions (mesh\_regions) even with different physical properties, but to be treated together somewhere in the simulation (e.g. quantum calculation). In this way it is possible to refer to the set of these regions simply by the **Cluster** name.

Each **Region** block must be preceded by the keyword "**Region**", followed by the (single-word) name of the **TiberCAD Region**. The name of the **TiberCAD Region** can coincide with the name of a mesh region, as defined during the modeling of the device; in this case, if the keyword *mesh\_regions* is absent, the **TiberCAD Region** will be associated to the mesh region identified by the name assigned to the **TiberCAD Region**. Otherwise, the **TiberCAD Region** will be associated to the mesh regions.

```
Region QWell
{
    mesh_regions = (4,5)
    # mesh_regions = 4
    structure = wz
    y-growth-direction = (1,0,-1,0)
    z-growth-direction = (-1,2,-1,0)
    x-growth-direction = (0,0,0,1)
    material = GaN
    doping = 1e17 doping_type = donor doping_level = 0.025
}
```

Here are the description of the available keywords for a **Region** block.

material (mandatory): name of the material associated to the present region, e.g Si; it may be a ternary alloy, e.g AlGaAs, in this case keyword x described in the following has to be present.

x: alloy concentration, expressed as the molar fraction of the first component of the alloy; e.g. to express an alloy  $Al_xGa_{1-x}As$  with molar fraction x = 0.2, that is  $Al_{0.2}Ga_{0.8}As$ , we select **AlGaAs** for the keyword *material*, and 0.2 for the keyword x, thus we write x = 0.2.

 $mesh\_regions$ : (a list of) region ID(s) or physical name(s) as specified in the meshing program.

structure : crystal structure (wz = wurtzite, zb = zincblend)

*x-growth-direction*, *y-growth-direction*, *z-growth-direction*: Bravais vectors with Miller indexes for wurtzite crystal (4 element vectors) or zincblende crystal (3 element vectors).

doping: doping concentration [cm<sup>-3</sup>]

*doping\_type* : donor or acceptor

*doping\_level*: energy level of the dopant [eV]

Each **Cluster** block must be preceded by the keyword "**Cluster**", followed by the (single-word) name of the **Cluster**.

```
Cluster Quantum_1
{
    mesh_regions = (3,4,5)
}
```

*mesh\_regions* (mandatory): list of physical regions (region IDs or physical names) or TIBERCAD region names, as specified in the meshing program, to be grouped in the cluster.

**Regions** and **Clusters** represent the macroscopical description of the device or structure to be be simulated in **TiberCAD**. In the rest of the input file, the physical regions associated to **Models** or **Atomistic** descriptions will be indicated by means of the **TiberCAD** Region and **Cluster** names.

### 4.3 Scale section

The section "Scale" is dedicated to the optional definition of Non-Continuous Media regions for the device: these regions will be described and studied at a different scale (e.g. atomistic, circuit level lumped model, etc.) As for now, just the atomistic description is implemented. Atomistic blocks, if present, specify a possible atomistic description associated to one or to a group of physical regions described by **Region** blocks. So, for each Atomistic block defined in Input file, an atomic structure description will be generated and used to solve a simulation problem with an atomistic approach. The association to the physical (macroscopic) regions of the device allows the implementation of multi-scale calculations.

Each **Atomistic** block must be preceded by the keyword "**Atomistic**", followed by the (single-word) name of the atomistic region.

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Here are the description of the available keywords for an **Atomistic** block.

*physical\_regions* (mandatory): list of the physical regions (**TiberCAD Regions** or **Clusters**) of the device associated to an atomistic description. *all* (default) is used to specify all the physical regions.

*path* (optional): path for importing an atomistic structure from an external file. *xyz* and *gen* formats are supported, and are automatically recognized by file extension. Each of the atom positions is imported as is, so the atom coordinates must be consistent with the geometry of the device.

If no path is specified, the **TiberCAD Atomistic Generator** builds the atomistic structure; it is constructed as a bulk crystal structure, covering with proper atomic species the physical regions and taking in account the dimension of the problem (up to now 1D structures are supported)......

Atomistic Generator options, to be put in the Atomistic section, are described in the following.

*reference\_region* (mandatory): the Atomistic Generator can only build pseudomorphical heterostructures. A reference region must be defined to specify from which region (**TiberCAD Regions**) to get structure parameters such as lattice constants, which depend on the material defined in the reference region.

*passivation* (optional): *no* is default option. If set to *no*, no passivation is performed. If *yes* is specified, a hydrogenation of the structure is performed, taking into account the structure periodicity. Up to now, hydrogenation is supported fo Silicon structures.

preserve (optional): Default is none. In some cases it is requested to build a structure in which the atom basis or the conventional cell has be preserved, regardless to mesh geometry. If none is specified, no conservation is performed and only atoms strictly belonging to geometrical regions are put in the atomic structure. If *lattice* is specified, atom basis is preserved (e.g. to preserve anion/cation couples). If *conventional* is specified, conventional cell is preserved. .....

 $y\_lenght$  (optional): Atomistic Generator builds the minimum periodical structure along y and z directions. If  $y\_lenght$  is specified, the structure will be at least  $y\_lenght$ sized along  $y\_growth\_direction$ . Exact lenght is internally defined in order to keep structure periodicity.

 $z_{lenght}$  (optional): same as above, for the z direction.

## 4.4 Models section

```
$Models
{
  model driftdiffusion
  {
```

```
. . . . . . . . . .
  BC_Regions
   {
     BC_Region cathode
     ſ
       . . . . . . . . . . . .
     }
     BC_Region anode
     {
        . . . . . . . . . . . . . .
     }
   }
 }
model macrostrain
 {
```

In "**Models**" section, one or more model-blocks must be present: each model-block must be preceded by the keyword "**model**", followed by the (single-word) model name. This must be the name of one of the TIBERCAD simulation models.

Here are the simulation models implemented until now:

- driftdiffusion: Poisson-driftdiffusion transport of electrons and holes
- thermal: Heat balance simulation
- excitontransport: Exciton transport model
- macrostrain: Calculation of Elastic deformations in heterostructures
- efaschroedinger: Envelop Function Approximation (EFA) solution of singleparticle Schrödinger equation for electrons and holes
- quantum density: Calculation of quantum density of electrons and holes.
- quantum dispersion: Dispersion of quantized states in  ${\bf k}$  space
- opticskp: Optical properties (optical kp matrix elements)
- opticalspectrum: Emission spectrum (with k-space integration)

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For a complete description of these simulation models, see the next chapters.

Each model-block can contain some optional blocks, to be written in the following order:

- one "options" block, preceded by the keyword "**options**". This block can contain general options for the present model.
- one or more **physical\_model** blocks: each physical\_model block must be preceded by the keyword "**physical\_model**", followed by the (single-word) name of the physical model. Each physical\_model block can contain parameters relevant to a specific model of a physical property or quantity related to the present model.
- one or more Boundary Condition regions blocks (**BC\_regions**-block). The BC\_regions-block must be preceded by the keyword "**BC\_Regions**" and it is composed by one or more parameters-blocks, each preceded by the keyword "**BC\_-Region**" followed by the (single-word) name of the boundary condition region. This parameters-block can contain the possible description of the boundary region.

These optional blocks must be strictly in this order: first the **options**, then the **physical\_model**, and finally the **BC\_regions**-blocks. A detailed description of the possible parameters for these blocks follows.

### 4.4.1 options block

```
options
{
    simulation_name = dd1
    #physical_regions = all
    physical_regions = (channel_1, channel_2)
}
```

*simulation\_name*: user-defined name of the particular instance of the simulation model defined for this block. More than one simulation (with different name and properties) can be defined, in separated model blocks, which refer to a same TIBERCAD simulation model. If simulation\_name is not assigned, by default the TIBERCAD model name is taken as current simulation\_name.

*physical\_regions*: (list of) physical region(s) to which the present simulation model will be applied. Physical region(s) are the **TiberCAD regions** or **clusters** as defined in **Device** section

Default value is "all" (all physical regions of the device). In a list, the names must be separated by comma and enclosed between '(' and ')' parenthesis

## 4.4.2 physical\_model block

```
physical_model recombination
{
    model = SRH
}
```

The following options can be applied to any physical\_model:

name a user defined name for the model for unique identification

restrict\_to\_region a single region name or a list of regions where the model should be used. This allows to use different implementation of the same type of model in different regions.

### 4.4.3 BC\_region block

```
BC_Region anode
{
    BC_reg_numb = 2
    type = ohmic
    #voltage = 0.0
    voltage = @Vb[1.5]
}
```

*BC\_region*: name of the present boundary region; it can be the name of a boundary (physical) region specified in the meshing program (GMSH or ISE-TCAD).

 $BC\_reg\_numb$ : BC region ID(s) as specified in the meshing program (GMSH). If this keyword is not present, it is assumed that the mesh region associated to this **TiberCAD BC region** is given by the name assigned to  $BC\_region$ .

type: type of boundary condition: ohmic, schottky,... , substrate (for strain calculations).

*voltage*: value of voltage [V] applied to the present BC region (for ohmic and schottky BCs); it can be the value of a sweep variable 'Vb', indicated with @Vb. A possible default value can be indicated in parenthesis: @Vb[1.5]

*zero\_grad\_fermi\_h*, *zero\_grad\_fermi\_e*: if true set Neumann b.c. to the fermi level in the b.c. region.

If type is substrate (for strain calculations):

material : name of material in the substrate region.

structure : crystal structure (wz = wurtzite, zb = zincblend)

x-growth-direction, y-growth-direction, z-growth-direction: Bravais vectors with Miller indexes for wurtzite.

## 4.5 Solver section

```
$Solver
{
driftdiffusion
  {
    nonlinear_solver = tiber
    ksp_type = bcgsl
    nonlin_rel_tol = 1e-12
    nonlin_abs_tol = 1e-15
    nonlin_step_tol = 1e-2
    #nonlin_rel_tol = 1e-12
    lin_rel_tol = 1e-6
    nonlin_max_it = 30
    ls_max_step = 1
    #pc_type = lu
    pc_type = composite
  }
 . . . . . . . . . . . . . . . . . . .
```

In this section one may choose and define the setting parameters for the numerical solvers to be applied to the specified simulations: the section is organized in blocks, each one preceded by a block-name. This block-name may be

- 1. the name of one of the user-defined simulations: in this case, the solver parameters defined in each block will refer only to that particular simulation.
- 2. the name of a TIBERCAD**Model**: only in this case, the settings will be applied to *all* the simulations belonging to that **Model**

For details on the available parameters for each  $\mathbf{Model}$  , see the relevant chapter in this Guide.

In addition, two special (optional) blocks may be present: the **Sweep** block and the **Selfconsistent** block

• Sweep block, preceded by the keyword "Sweep". This block may contain one or more subblocks, each one defining a set of calculations applied to a boundary region (e.g. a set of bias values to be assigned to a drain contact of a MOSFET for the calculation of an output drain IV characteristic), in this Guide referred to as *sweep* calculation.

Each *sweep* definition must be preceded by its user-defined name (e.g.  $sweep_1$ ). (see Listing 1)

In the case of a single sweep subblock, for backward compatibility, it is also allowed to define the *sweep* feature by means of the keyword **sweep** (lower case), in the following way:

```
sweep
{
    simulation = driftdiffusion
    variable = Vb
    start = 0.0
    stop = 4.0
    steps = 80
    plot_data = true
    plotvariable = current
}
```

The following keywords are defined for this feature:

**variable**: name of the variable to which the *sweep* is applied: its value is assigned to a quantity (e.g. voltage) in a BC Region section to perform the *sweep* calculation (see 4.4.3).

**start**, **stop**, **steps**: sweep starts from *start* value, is repeated *steps* times and stops in *stop* 

**simulation**: name of the simulation (model) associated to the sweep calculation; it may be the name of another sweep defined in the same block.

**plotvariable** (obsolete): specify the integrated quantity to be calculated during the sweep and that will be shown in the output file sweep\_modelname\_sweepvariable.dat, eg. sweep\_driftdiffusion\_Vb.dat for a sweep of current calculation on the variable Vb (typically a contact voltage).

```
Sweep
{
  sweep_1
  {
    simulation = driftdiffusion
    variable = Vd
    start = 0.0
    stop = 2.0 \# 0.1
    steps = 20 #50
   plot_data = true
 #
 }
  sweep_2
  {
    variable = Vg
    start = -0.1
    stop = 1.0 #0.5
    steps = 11 # 6
    simulation = sweep_1
    #simulation = driftdiffusion
   plot_data = true
  }
}
```

Listing 1: Example of Sweep section

**plot\_data**: default is *false*; if it is set to *true*, then output data will be written for each step of the sweep calculation, otherwise just the results for the final step will be present in the output.

Once a *sweep* calculation has been defined, it is treted as a special case of simulation and may be executed as an usual *simulation*: by adding it in the **solve** list, e.g.  $solve = sweep\_drain$  (see 4.7).

• Selfconsistent block, preceded by the keyword "Selfconsistent". This block may contain one or more subblocks, each one defining a self-consistent calculation based on two different simulation models (e.g. driftdiffusion and excitontransport). The definition of a *selfconsistent* calculation must be preceded by its user defined name (e.g. *converse\_piezo*):

```
Selfconsistent
{
    converse_piezo
    {
      flavour = relaxation
      simulations = (driftdiffusion, strain)
    }
    dd_excitons
    {
      flavour = relaxation
      simulations = (driftdiffusion, exciton)
    }
}
```

Listing 2: Example of Selfconsistent section

The following keywords are defined for this feature: simulations: the list of simulations to be performed self-consistently. flavour: specifies broyden or relaxation approach

#### 4.6. PHYSICS SECTION

Once a *selfconsistent* calculation has been defined, it may be executed as an usual *simulation*: by adding it in the **solve** list, e.g.  $solve = dd\_excitons$  (see 4.7), or even in the **sweep** section, with, for example, *simulation* = *converse\_piezo*. In both cases, the specified simulations will be executed in a self consistent way.

In the case of a single self-consistent calculation block, for backward compatibility, it is also possible to define the *self-consistent* feature by means of the keyword **selfconsistent**(lower case), in the following way:

```
selfconsistent
{
   flavour = relaxation
   simulations = (driftdiffusion, excitons)
}
```

# 4.6 Physics section

In this section several physical parameters can be entered, in addition to or overwriting the material parameters present in the material files. The section is organized in blocks, each one preceded by a block-name.

This block-name may be

- 1. the name of one of the user-defined *simulations*: in this case, the physical parameters defined in each block will refer only to that particular simulation.
- 2. the name of a TIBERCAD**Model**: only in this case, the settings will be applied to ALL the *simulations* belonging to that **Model**

For details on the available parameters for each  $\mathbf{Model}$  , see the relevant chapter in this Guide.

For example in this case:

strain\_simulation is used to specify the simulation that provides strain data, in case of strained systems (see 6.4).

# 4.7 Simulation section

In this section one can specify several general parameters and settings for the actual calculation to be run, such as the mesh file to be used, the dimension of simulation, the process-flow of simulation, etc.

searchpath: path for material files

```
driftdiffusion
{
   strain_simulation = strain
}
```

meshfile: name of mesh file. N.B.: the extension is mandatory! ( .grd for ISE-TCAD, .msh for GMSH mesh file v.1 and v.2.0 )

<code>mesh\_units:</code> units of measurements used in the meshing (relative to meters): e.g.,  $10^{-6}$  for  $\mu m$ 

dimension: dimension of simulation (1,2,3)

temperature: temperature of the system [K]

*solve*: list of simulations to be executed, in the order of execution; if the list contains "sweep", a sweep is performed as specified in *sweep* block in the *Solver* section.

solve = (strain,driftdiffusion, quantum\_electrons, quantum\_holes)

resultpath: path for output directory

*output\_format*: format of the output data: *gmv* for **GMV**, *ise* for **Tecplot**, *grace* for **xmgr** (ascii data column type), *vtk* for **Paraview**.

*plot*: list of output variables which are calculated and available in output files. See the corresponding chapters for the available output variables for each model.

# 4.8 Output description

At the end of the execution, the program will write the results of the simulation in the directory specified by *resultpath*, with the format specified by *output\_format*. The output variables are specified in the list *plot*.

TiberCAD output is divided in three classes: **nodal**, **elemental** and **integrated** quantities.

Nodal quantities are all the quantities associated with the nodes of the mesh, such as Fermi level, electron and hole density, conduction and valence band, etc. The output values for these quantities are reported in the files *modelname\_nodal.ext*, where *modelname* is the simulation model used for the calculations and *ext* is the extension of the chosen file format.

#### 4.9. EXAMPLE OF INPUT FILE

In the case a sweep calculation is performed and the **plot\_data** keyword is set to *true*, the output files are of the kind *modelname\_nodal\_sweepvariable\_step.ext*, where *sweepvariable* is the variable with respect to which the sweep is performed (e.g. gate voltage) and *step* is the value of this variable at that step; e.g *driftdiffusion\_nodal\_Vb\_0.000.dat* for the result at the step Vb = 0.0.

**Elemental** quantities are all the quantities associated with the elements of the mesh, such as current density. The output values for these quantities are reported in the files  $modelname\_elemental.ext$ .

In the case a sweep calculation is performed and the **plot\_data** keyword is set to *true*, the output files are of the kind *modelname\_elemental\_sweepvariable\_step.ext*. e.g. *driftdiffusion\_elemental\_Vb\_1.150.dat* 

**Integrated** quantities are the quantities which are not associated to the mesh but are obtained by an integration on real or reciprocal space, for example current at the contacts of a diode or quantized energy levels in a quantum well. These **Integrated** quantities are displayed in separated files, with the format *simname.ext*, e.g *quantum\_electrons.dat*, where *simname* is the name of the model (simulation) associated to the results. If a sweep is performed, the output file gets the format sweep\_*simname\_varname.ext*, where *varname* is the variable with respect to which the sweep is performed, for example *sweep\_driftdiffusion\_Vb.dat*. Inside the file, output values for all the steps of calculation are shown.

Finally, a last class of output files is the **Materials** output. These files contain the information about the physical regions of the device; for each class of simulation, a different material file is produced, containing all and only the mesh regions associated to that simulation model. The file has the format *simulationname\_materials.ext*, e.g. *driftdiffusion\_materials.dat* 

## 4.9 Example of Input file

Here is an example of the input file template:

```
# Description of the device physical regions
$Device
{
    # Syntax:
    #
# Region "Tiber_region"
```

```
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                                     CHAPTER 4. INPUT FOR TIBERCAD
# mesh_regions = "list gmsh region ID/names" | "list ISE_TCAD region names"
#
#if mesh_regions is empty -> mesh_regions = "Tiber_region"
#
 Region buffer
   {
     mesh_regions = 1
     structure = wz
     y-growth-direction = (1,0,-1,0)
     z-growth-direction = (-1,2,-1,0)
     x-growth-direction = (0,0,0,1)
     material = GaN
     doping = 1e15
     doping_type = donor
     #doping_level = 0.025
   }
 Region barrier_1
   {
    mesh_regions
                     = (2,3)
     structure = wz
     y-growth-direction = (1,0,-1,0)
     z-growth-direction = (-1,2,-1,0)
     x-growth-direction = (0,0,0,1)
     material = AlInN
     x =
            0.80 #
     doping = 1e15
     doping_type = donor
     #doping_level = 0.025
   }
 Region QWell
   {
     mesh_regions = 4
```

```
structure = wz
     y-growth-direction = (1,0,-1,0)
     z-growth-direction = (-1,2,-1,0)
     x-growth-direction = (0,0,0,1)
    material = GaN
     doping = 1e15 \#
     doping_type = donor #
     # doping_level = 0.025
   }
Region barrier_2
  {
    mesh_regions = (5,6)
     structure = wz
     y-growth-direction = (1,0,-1,0)
     z-growth-direction = (-1,2,-1,0)
     x-growth-direction = (0,0,0,1)
    material = AlInN
     x = 0.80 #
     doping = 1e15 \#
     doping_type = donor
     # doping_level = 0.025
   }
# Cluster = group of mesh_regions with DIFFERENT material (in general)
# Syntax:
#
# Cluster "Tiber_cluster"
# mesh_regions = "list gmsh region ID/names" | "list ISE_TCAD region names"
#
  "Tiber_cluster" to be used in Models section
#
  Cluster Quantum_1
  {
     mesh_regions = (3, 4, 5)
```

```
}
}
#Definition of the description scale (only for not-Continuous Media regions )
# Syntax:
#
# "level" "scale_cluster"
# "level" = "Atomistic | ..."
# physical_regions = "list (Tiber_region | Tiber_cluster) "
#
#****** $Scale section is optional *******
#
$Scale
{
  Atomistic TB_1
 {
   physical_regions = (barrier_1 , QWell , barrier_2 )
  }
  Atomistic TB_2
  {
   physical_regions = .....
  }
}
```

```
# Definition of Simulation Models and associated Boundary Conditions
$Models
{
model driftdiffusion
  {
    options
    {
    simulation_name = dd1
    physical_regions = all
    }
   physical_model recombination
    {
     model = srh
    }
    physical_model recombination
    {
     model = direct
      C = 1.1e-8
    }
    BC_Regions
    {
      BC_Region cathode
      {
       BC_reg_numb = 1
       type = ohmic
       voltage = 0.0
      }
```

```
BC_Region anode
      {
        BC_reg_numb = 2
        type = ohmic
voltage = 0.0
      }
    }
 }
 model macrostrain
  {
    options
    {
      simulation_name = strain
      physical_regions = all
    }
    BC_Regions
    {
      BC_Region substr
      {
        BC_reg_numb = 1
type = substrate
        material = GaN
structure = wz
        y-growth-direction = (1,0,-1,0)
        z-growth-direction = (-1,2,-1,0)
        x-growth-direction = (0,0,0,1)
      }
   }
  }
```

```
model efaschroedinger
  {
    options
    {
      simulation_name = quantum_electrons
# Syntax:
#
# physical_regions = "list (Tiber_region | Tiber_cluster) "
      physical_regions = Quantum_1
    }
  }
 model efaschroedinger
  {
    options
    {
     simulation_name = quantum_holes
    physical_regions = Quantum_1
    }
  }
}
# Definition of Model-dependent Solver parameters
```

```
driftdiffusion
  {
    coupling = poisson
   ksp_type = bcgsl
   nonlin_abs_tol = 1e-10
    nonlin_step_tol = 1e-2
    #nonlin_rel_tol = 1e-12
    lin_rel_tol = 1e-6
    nonlin_max_it = 30
    #local_density_scaling = true
    #ls_type = none
    discretization = fem
    ls_max_step = 1
    #pc_type = lu
   pc_type = composite
    integration_order = 2
   #relaxation_factor = 0.5
  }
macrostrain
  ſ
   substrate = substr
  }
  efaschroedinger
  {
   x-periodicity = false
   Dirichlet_bc_everywhere = true
#
  particle = hl
   number_of_eigenstates = 30
# model = conduction_band #eff mass cb
   poisson_model_name = driftdiffusion # potential from driftdiffusion
    strain_model_name = macrostrain
    convergent_density = true
```

{

```
}
 quantum_electrons
  {
   particle = el
  }
 quantum_holes
  {
   particle = hl
  }
}
# Definition of Model dependent physical parameters
$Physics
{
  driftdiffusion
  {
    statistics = FD
    strain_simulation = macrostrain # default driftdiffusion model including
     # local strain obtained from "macrostrain"
  }
 quantum_electrons
  {
   particle = el
   model = conduction_band #eff mass cb
  }
  quantum_holes
  {
```

```
particle = hl
    model = kp # k.p for valence band
    kp_model = 6x6
  }
}
# Definition of model-indipendent parameters of the Simulation
$Simulation
{
 searchpath = ../../materials
                        #nm !!
mesh_units = 1e-9
 dimension = 1
meshfile = test.msh
 temperature = 300
  solve = (strain, driftdiffusion, quantum_electrons,quantum_holes )
  resultpath = output_
  plot = (Ec, Ev, QFermi_e, QFermi_h, EField ,
          eDensity, hDensity, eCurrent, hCurrent,
          Current, NetRecombination, eMob, hMob, T,
            strain, polarization, xEffPot, xDensity,
          xMob, ExcitonRecombination, EigenFunctions,
          EigenEnergy,EnergyLevels, xCurrent)
  output_format = grace
}
```

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4.9. EXAMPLE OF INPUT FILE

# Chapter 5

# Simulation of strain

# 5.1 Theory

The theoretical model of strain simulation can be found in Refs.[1, 2]. The code can compute elastic deformations in a heterostructure and can calculate the deformed shape of the structure. The heterostructure can be either grown on a substrate or not. External pressure may be applied to a structure as well.

# 5.2 Models section parameters

The **Models** section looks like follows:

There are three possible kinds of boundary conditions. The mandatory keyword  $type = \{ \text{ substrate } | \text{ pressure } | \text{ extended_material} \}$  specifies the boundary condition type.

#### 5.2.1 Substrate boundary condition

In this case the boundary condition region (see 1.2) is the boundary between the device and the substrate. The substrate does not belong to the device. Therefore it is necessary to define both the boundary region number and the substrate material

**Role of substrate.** In general, the "substrate" is a material that defines the lattice matching conditions, and not necessarily a real solid body on which the device is grown.

```
BC_Region layer_of_Al_0.3_Ga_0.7_N
{
     BC_reg_numb = 14
     type = substrate
     mat = AlGaN
     x = 0.3
     structure = wz
     y-growth-direction = (1,0,-1,0)
     z-growth-direction = (-1,2,-1,0)
     x-growth-direction = (0,0,0,1)
}
```

### 5.2.2 External pressure boundary condition

The parameter *pressure* specifies the value (in GPa) of the normal pressure applied to the boundary region  $BC\_reg\_numb$ .

```
BC_Region tip_upon_a_surface
{
    BC_reg_numb = 12
    type = pressure
    pressure = 12.3
}
```

**Sign of pressure.** The value of the pressure has a positive sign if the external force acts towards the surface, which in general has to be the boundary of a simulation environment.

## 5.2.3 Extended device boundary condition

If device that is grown on a substrate is very large we may want to simulate a part of it only. In this case the simulation domain boundary is not a free surface any more. The boundary conditions are as follows:

$$\int C_{ijkl} \frac{\partial u_k}{\partial x_k} n_i d\partial\Omega = 0 \tag{5.1}$$

The syntax is as follows:

```
BC_Region boundary1
{
    BC_reg_numb = 12
    type = extended_material
}
```

# 5.3 Solver parameters

The choice of the necessary parameters to be put in the **Solver** section depends on the type of the strain boundary condition for the structure, namely, if it is considered as grown on a substrate or not.

### 5.3.1 Structure with a substrate

The only mandatory parameter is *substrate*, to which a name of a substrate boundary condition region has to be assigned, e.g (referring to the previous example):

```
strain_in_transistor
{
    substrate = layer_of_Al_0.3_Ga_0.7_N
}
```

## 5.3.2 Structure without a substrate (freestanding)

In this case, the parameter *substrate* should not be present; instead, the following parameters should be defined.

• The reference lattice material is defined by the coordinates of a point belonging to this material, using the parameter *reference\_material\_point*.

• As follows from Ref. [1], additional geometrical points have to be specified, according to the device dimensionality. The corresponding parameters are: *fixed\_point1*, *fixed\_point2* and *fixed\_point3*.

Since the elasticity energy is invariant with respect to translations and rotations of the structure, then, for the sake of uniqueness of solutions of the equations, another set of constraints is required. Hereafter we assume that a mesh is defined over the simulation domain and the displacement field  $\mathbf{u}(\mathbf{r})$  is defined at the mesh nodes.

Let  $\mathcal{D}$  be the dimensionality of the structure minus the number of directions along which the structure is periodic. If  $\mathcal{D} > 0$ , then a Dirichlet boundary condition is applied at an arbitrarily chosen node  $i_1$ :

$$\mathbf{u}(\mathbf{r}_{i_1}) = \mathbf{0},\tag{5.2}$$

in order to prevent the structure from undesirable translations. In the case of  $\mathcal{D} > 1$ , another node  $i_2$  is chosen and a constraint

$$\left(\mathbf{u}(\mathbf{r}_{i_1}) - \mathbf{u}(\mathbf{r}_{i_2})\right) \cdot \left(\mathbf{r}_{i_1} - \mathbf{r}_{i_2}\right) = 0 \tag{5.3}$$

is applied, in order to keep the direction between the nodes  $i_1, i_2$  unchanged. If  $\mathcal{D} = 3$ , another node  $i_3$  is chosen and additional constraint is set:

$$(\mathbf{r}_{i_1} - \mathbf{r}_{i_2}, \mathbf{r}_{i_1} - \mathbf{r}_{i_3}, \mathbf{u}_{i_3}) = 0, \tag{5.4}$$

so the node  $i_3$  has to belong to the  $(\mathbf{r}_{i_1}, \mathbf{r}_{i_2}, \mathbf{r}_{i_3})$  plane. Example for a 2D simulation:

```
strain_in_transistor
{
   reference_material_point = (0, 100, 0)
   fixed_point1 = (0, 0, 0)
   fixed_point2 = (10, 0, 0)
}
```

#### 5.3.3 Additional parameters

#### Numercal solver parameters

tolerance: relative tolerance of the iterative solver, e.g.

```
tolerance = 1e-10
```

The default value is 1e-10.

 $ksp\_type = type \text{ of solver: gmres, bcgsl, bcgs, cg, richardson.}$ Default is: 5.3. SOLVER PARAMETERS

- gmres for 1D
- **bcgsl** for 2D and 3D

pc = type of pre-conditioner : ilu, composite, jacobi, lu, cholesky, eisenstat. Default is :

- ilu for 1D
- jacobi for 2D and 3D

max\_iterations = max number of iterations (default = 1000)
monitor, xmonitor: if true, textual or graphical monitor of convergence process is
enabled (default = false)

#### Periodic boundary conditions

It is possible to specify periodic boundary conditions along the coordinate axes. The relative parameters are:

 $periodicity\_x = \{ \text{ true } | \text{ false } \}$  $periodicity\_y = \{ \text{ true } | \text{ false } \}$  $periodicity\_z = \{ \text{ true } | \text{ false } \}$ The default value is **false**.

#### Mesh refinement

For the details about mesh refinement refer to the Libmesh library documentation. The parameter *refinement\_steps* defines the number of the refinement steps to be done (with default value equal to zero). The parameter *uniform\_refinement* = { true | false } is used to choose between uniform and adaptive refinement. The default value is **false**, i.e. adaptive refinement. Example:

refinement\_steps = 4
refine\_fraction = 0.25
coarsen\_fraction = 0
max\_refinement\_level = 10

#### Deformed shape calculation

The displacement field and lattice matching parameters that are found from master equations can be used in order to define a new shape of the heterostructure. This new shape is the first approximation to the equilibrium one. The next approximations are obtained iteratively by the following steps: at the *n*-th iteration the master equations are solved using the lattice matching deformation  $\varepsilon_{ij}^n$  which is defined as

$$\varepsilon_{ij}^{n} = \frac{1}{2} \left( \frac{\partial u_{i}^{n-1}}{\partial x_{j}} + \frac{\partial u_{j}^{n-1}}{\partial x_{i}} \right) + \varepsilon_{ij}^{n-1}, \tag{5.5}$$

where the displacement field  $\mathbf{u}^{n-1}$  has been taken from the iteration n-1. Then the new shape is defined by using the displacements from the last step solution, and the iterative process is repeated until the displacement field vanishes and additional lattice parameters stabilise. The iterative cycle usually converges after 3 - 4 iterations.

The only parameter that controls shape calculation is *number\_shape\_steps*. The value defines number of iterations. The default value is zero, that means no shape deformation calculation.

## 5.4 Physics section parameters

There is a possibility to consider converse piezoelectric effect. For this it is necessary to specify a name of another simulation that can provide electric field. The parameter is *poisson\_equation*. Example:

```
macrostrain
{
    poisson_equation = DriftDiffusion
}
```

**Interaction with other simulations.** In order to take into account the converse piezzo effect, the poisson equation has to recalculate the necessary parameters after the strain simulation. To do so, the following parameters has to be set in the Physics section of the drift-diffusion equation (for detailes see Sec. 6.4):

```
driftdiffusion
{
    model = strained
    strain_simulation = str
    recompute_band_parameters = true
}
```

## 5.5 Output

The output variables are:

#### $5.5. \quad OUTPUT$

- strain strain tensor (6 components) in calculation system
- stress stress tensor (6 components) in calculation system
- polarization piezo polarization vector (3 components) in calculation system

Plot keyword	label	$\mathbf{Units}$
strain	eps	
stress	stress	GPa
polarization	polarization	$C/cm^{-2}$

 Table 5.1:
 Elemental vector quantities

By using StrainVariables as a plot keyword it's possible to include all quantities of the strain simulation.

# Chapter 6

# Drift-diffusion simulation of electrons and holes

## 6.1 Theory

The semi-classical transport simulation of electrons and holes is based on the driftdiffusion approximation (see e.g. [3]).

Beside the electric potential the electro-chemical potentials are used as variables such that the system of PDEs to be solved reads as follows

$$-\nabla(\varepsilon\nabla\varphi - \mathbf{P}) = -e(n - p - N_d^+ + N_a^-)$$
  
$$-\nabla(\mu_n n(\nabla\phi_n + P_n \nabla T)) = R$$
  
$$-\nabla(\mu_p p(\nabla\phi_p + P_p \nabla T)) = -R$$
  
(6.1)

P is the electric polarization due to e.g. piezoelectric effects and R is the net recombination rate, i.e. recombination rate minus generation rate.  $P_n$  and  $P_p$  are the electron and hole thermoelectric power, respectively. The models for the mobilities and the net recombination rates can be specified in the physical\_model sections as described in the following.

# 6.2 Plot variables

See tables 6.1, 6.2 and 6.3.

### 6.3 Models section

The Models section looks as given in Listing 3

```
model driftdiffusion
{
    options
    {
         simulation_name = whatever_you_want
         physical_regions = (2, 3, 4)
    }
    physical_model recombination
    {
      model = model_to_be_used
    }
    physical_model electron_mobility
    {
      model = model_to_be_used
    }
    physical_model hole_mobility
    {
      model = model_to_be_used
    }
    physical_model thermoelectric_power
    {
      model = model_to_be_used
    }
 }
```

Listing 3: Models section for drift-diffusion

#### 6.3. MODELS SECTION

Nodal quantities		
Ec	Conduction band edge	eV
Ec0	Conduction band edge without electric po-	eV
	tential	
Ev	Valence band edge	eV
EvO	Valence band edge without electric potential	eV
Eg	Band gap	eV
QFermi_e	Electro-chemical potential of electrons	$eV(-e\phi_n)$
QFermi_h	Electro-chemical potential of holes	$eV(-e\phi_p)$
ElPotential	Electric potential	V
eDensity	Electron density	$\rm cm^{-3}$
hDensity	Hole density	$\mathrm{cm}^{-3}$
eMob	Electron mobility	$cm^2V^{-1}s^{-1}$
hMob	Hole mobility	$cm^2V^{-1}s^{-1}$
Nd	Ionized donor density	$\mathrm{cm}^{-3}$
Na	Ionized acceptor density	$\mathrm{cm}^{-3}$
charge_density	Total charge density	$\mathrm{cm}^{-3}$
Pn	Electron thermoelectric power	$V K^{-1}$
Рр	Hole thermoelectric power	$V K^{-1}$
NetRecombination	ecombination   The net recombination rate for each recom-	
	bination model and the total rate	

#### Na Jal .....

Table 6.1: Nodal quantities

The physical\_model sections can be omitted. In this case default models are used, namely no recombination/generation for the recombination model and constant mobility for the mobility models. There can be more than one recombination model.

#### 6.3.1**Recombination models**

This section describes the currently available generation/recombination models.

#### Shockley-Read-Hall (SRH) recombination

The SRH recombination model can be enabled in the input file by

```
physical_model recombination
{
  model = srh
  . . .
}
```
EField	Electric Field	$V cm^{-1}$		
GradFermiE	Gradient of the electron	$V cm^{-1}$		
	electro-chemical potential			
GradFermiH	Gradient of the hole electro-	$V cm^{-1}$		
	chemical potential			
Current	Total current density	$Acm^{-2}$		
eCurrent	Electron current density	$Acm^{-2}$		
hCurrent	Hole current density	$Acm^{-2}$		
Polarization	Electric Polarization	$\mathrm{Cm}^{-2}$		
GradPn	Gradient of electron ther-	$VK^{-1}cm^{-1}$		
	moelectric power			
GradPp	Gradient of hole thermo-	$VK^{-1}cm^{-1}$		
	electric power			

#### **Elemental quantities**

 Table 6.2:
 Elemental quantities

Scalar quantities		
ContactCurrents	Contact currents	* <mark>a</mark>

<sup>*a*</sup>depends on dimension and symmetry

Table 6.3: Scalar quantities

SRH recombination is defined as follows:

$$R_{SRH} = \frac{np - n_i^2}{(n + n_i e^{E^*/k_B T})\tau_p + (p + n_i e^{-E^*/k_B T})\tau_n}$$
(6.2)

 $E^* = E_{trap} - (E_c + E_v)/2$  is the trap level with respect to the midband energy.  $n_i$  is the intrinsic carrier density,  $\tau_n$  and  $\tau_p$  are the recombination times. The parameters are taken from the material database. The recombination times are dependent on temperature and doping density, e.g.

$$\tau_n = \tau_n^0 \left(\frac{T}{T_0}\right)^{\alpha_n} e^{\beta(T/T_0 - 1)}$$
(6.3)

$$\tau_n^0 = \tau_{min,n} + \frac{\tau_{max,n} - \tau_{min,n}}{1 + (N/N_{ref})^{\gamma}}$$
(6.4)

where  $T_0$  is the reference temperature (300 K). Table 7.2 shows the corresponding parameters for the material data files. The parameters for holes and electrons have to be specified in an array, e.g. taumin = (1e-5, 3e-6)

parameter	keyword
$ au_{min}$	taumin
$ au_{max}$	taumax
$N_{ref}$	Nref
$\gamma$	gamma
$E^*$	Etrap
$\alpha$	Talpha
$\beta$	Tcoeff

Table 6.4: SRH material data file parameters

The recombination times and trap level can be overridden from the input file by using the keywords of table 6.5 in the appropriate physical\_model section or in the Region section (the latter overrides the former).

$$\begin{array}{c|c} tau_n \\ tau_p \\ E^* \\ E^* \end{array} \begin{array}{c} \texttt{tau_n} \\ \texttt{tau_p} \\ \texttt{E_t} \end{array}$$

 Table 6.5:
 SRH input file parameters

#### Direct (radiative) recombination

The direct recombination model can be enabled in the input file by

```
physical_model recombination
{
    model = direct
    ...
}
```

Direct recombination is modeled as follows:

$$R_{direct} = C(np - n_i^2) \tag{6.5}$$

The material data file and the input file use the same keyword C for the parameter C. The database value can be overridden from the input file as described for SRH recombination.

#### Auger recombination

The Auger recombination model can be enabled in the input file by

```
physical_model recombination
{
    model = auger
    ...
}
```

Auger recombination is modeled by the following equation

$$R_{auger} = (C_n n + C_p p)(np - n_i^2)$$
(6.6)

with temperature dependent parameters

$$C_{\{n,p\}} = \left(A + B\frac{T}{T_0} + C\left(\frac{T}{T_0}\right)^2\right) \left(1 + He^{-\{n,p\}/N_0}\right)$$

The parameters A, B, C, H and  $N_0$  are taken exclusively from the database. They are different for  $C_n$  and  $C_p$  and have to be specified as arrays with keywords A, B, C, H, NO, e.g. A = (1e-31, 1e-32). The calculated values for  $C_n$  and  $C_p$  can be overridden from the input file by specifying values for the keywords Cn and Cp.

#### 6.3.2 Thermoelectric power models

The thermoelectric power models are the same for electrons and holes. The keyword is thermoelectric\_power, i.e

```
physical_model thermoelectric_power
{
    model = ...
}
```

The model keyword can be constant (i.e. the thermoelectric powers are read from the database) or diffusivity\_model where the thermoelectric powers are computed by

$$P_n = -\frac{k_b}{q} \left( \frac{5}{2} + \frac{e\phi_n + E_c - e\varphi}{k_b T} \right) \tag{6.7}$$

$$P_p = \frac{k_b}{q} \left( \frac{5}{2} - \frac{e\phi_p + E_v - e\varphi}{k_b T} \right) \tag{6.8}$$

The default is  $P_n = P_p = 0$ .

6.3. MODELS SECTION

### 6.3.3 Mobility models

Mobility models have currently to be defined for electrons and holes independently. The corresponding keywords are electron\_mobility and hole\_mobility, i.e.

```
physical_model electron_mobility
{
    model = ...
}
physical_model hole_mobility
{
    model = ...
...
}
```

The default model is the constant mobility model. The parameters for the different mobility models are needed for both electrons and holes. In the material files they are specified with a common keyword in arrays, e.g.

[mobility	7/c	onstant]		
#		electron	s	holes
mu_max	=	(1400.0	,	250.0)
exponent	=	(1.0	,	2.1)

### Constant mobility model

The constant mobility model (identifier constant) assumes a mobility which depends only on temperature by means of the following formula:

$$\mu_{const} = \mu_0 (T/T_0)^{-\gamma} \tag{6.9}$$

In the material data file  $\mu_0$  and  $\gamma$  have to be specified with the keywords mu\_max and exponent.  $\mu_0$  can be ovverridden from the physical\_model section using the keyword mu or from the Region sections using the keywords mu\_e and mu\_h.

#### Doping dependent mobility model

The doping dependent mobility model (identifier doping\_dependent) implements two models for mobility depending on the total doping density and the temperature. The model that is used depends on the value of the mobility\_formula parameter.

#### Model by Masetti et al. [4]

The model by Masetti et al. is identified by mobility\_formula = 1. It uses the following formula:

$$\mu = \mu_{min,1} * e^{-P_c/N} + \frac{\mu_{const} - \mu_{min,2}}{1 + (N/C_r)^{\alpha}} - \frac{\mu_1}{1 + (C_s/N)^{\beta}}$$
(6.10)

where N is the total doping density and  $\mu_{const}$  the mobility obtained from the constant mobility model. The parameters are specified in the material file as given in table 6.6.

keyword
mumin1
mumin2
mu1
Pc
Cr
Cs
alpha
beta

Table 6.6: Data file parameters for the mobility model by Masetti et al.

#### Model by Arora [5]

The model by Arora is identified by mobility\_formula = 2. It reads:

$$\mu = \mu_{min} + \frac{\mu_d}{1 + (N/N_0)^{A^*}}$$
with
$$\mu_{min} = A_{min} (T/T_0)^{\alpha_m}, \quad \mu_d = A_d (T/T_0)^{\alpha_d}$$

$$N_0 = A_N (T/T_0)^{\alpha_N}, \quad A^* = A_a (T/T_0)^{\alpha_a}$$
(6.11)

The parameters are given in table 6.7.

#### Field dependent mobility model

The field dependent mobility model describes the degradation of mobility at high driving fields. It is identified by the identifier field\_dependent. The electric field component in directon of the current flow or the gradient of the electro-chemical potential can be chosen as driving force:

driving\_force = efield | grad\_fermi

parameter	keyword
$A_{min}$	mumin
$A_d$	mud
$A_N$	NO
$A_a$	A
$\alpha_m$	am
$lpha_d$	ad
$\alpha_N$	aN
$\alpha_a$	aA

Table 6.7: Data file parameters for the mobility model by Arora.

The default driving force is the gradient of the electro-chemical potential.

The model is based on the Caughey-Thomas model, refined by Canali [6]:

$$\mu = \frac{\mu_{lowfield}}{\left(1 + \left(\frac{\mu_{lowfield}|\mathbf{E}|}{v_{sat}}\right)^{\beta}\right)^{1/\beta}}$$
(6.12)

with

$$\beta = \beta_0 (T/T_0)^b$$

 $|\mathbf{E}|$  is the modulus of the driving field,  $\mu_{lowfield}$  is the low-field mobility. For the latter one can specify the model to be used using the parameter lowfield\_model. As default the doping dependent model is used.

There are two models for  $v_{sat}$ , identified with Vsat\_Formula = 1 and 2. Formula 1 reads

$$v_{sat} = v_{sat,0} (T/T_0)^{-\gamma}$$

Formula 2 reads

$$v_{sat} = \max(A_{vsat} - B_{vsat}(T/T_0), v_{min})$$

The parameters for the field dependent mobility model are summarized in table 6.8.

#### 6.3.4 Boundary conditions

Boundary conditions are implemented for ohmic contacts, Schottky contacts, free surfaces and interfaces. Contacts are boundary models that allow a nonzero normal electrical current. For this type of boundaries one can define a contact resistance using the **contact\_resistance** option. The contact resistance has units  $\Omega \text{cm}^2$ . The applied voltage is specified with the option **voltage**. A variable can be assigned to this, using the **@**-syntax.

parameter	keyword
$\beta_0$	beta0
b	betaexp
$v_{sat,0}$	vsat0
$\gamma$	vsatexp
$A_{vsat}$	A_vsat
$B_{vsat}$	B_vsat
$v_{min}$	vsat_min

Table 6.8: Data file parameters for the mobility model by Arora.

For a finer control of the behaviour at electrical contacts, the options zero\_field, zero\_grad\_fermi\_e and zero\_grad\_fermi\_h can be used, which when set to true will impose zero normal electric field and zero normal gradient of the electron and hole electro-chemical potential, respectively. The ohmic contact (identifier ohmic) has no further parameters.

A Schottky contact (identifier schottky) has the additional parameter barrier, which signifies the energy difference between the semiconductor band edge and the fermi energy in the metal. As default, the barrier is taken with respect to the conduction band. By specifying band = v the barrier can be imposed with respect to the valence band (p-type contact). Alternatively, the metal work function can be defined using the keyword work\_function. Note, however, that its value has to be aligned with the band energies given in the material files for the other materials.

If a contact touches several different regions with different materials, it can be necessary to provide a reference material using the keyword reference\_material and specifying the name of a TIBERCAD region. TIBERCAD will prefer semiconductors over dielectrics if no reference material is specified.

The type of boundary model is chosen by the parameter type, e.g. type = schottky.

The free surface or interface model (identifier interface) models surface charges and surface recombination. Two modes are possible for the surface charge model:

- **constant charge** a constant charge can be assigned by specifying only the sheet carrier density Ns in  $cm^{-2}$ . The sheet charge density will then equal Ns multiplied by the elementary charge e. A positive Ns produces a positive surface charge.
- electronic surface states in this case the surface charge is produced by electrons occupying a surface state with a density of states in form of a delta function. The density of occupied states then reads

$$n_s = \frac{N_s}{1 + \frac{1}{g} \exp(\frac{E_c - \Delta E_s - e\varphi + e\phi_n}{k_B T})}$$

#### 6.4. PHYSICS SECTION

The density of states  $N_s$  is specified by Ns, the energy of the state with respect to the conduction band  $\Delta E_s$  by Es. g denotes the multiplicity of the state and defaults to 2. It can be changed by assigning a value to g.

Surface recombination is switched on by setting the keyword surface\_rec to true. The model used for surface recombination is formally the same as the bulk SRH recombination. However, the only parameters are the recombination velocities, which have to be specified (in cm/s) in the input file using the keywords rec\_vel\_e and rec\_vel\_h.

### 6.4 Physics section

Options for controlling the drift-diffusion semiconductor models can be specified in the **Physics** section. The corresponding parameters are given in table 6.9. When model is

keyword	possible val-	description
	ues	
model	(see following	the model to use for the descrip-
	subsections)	tion of the conduction and va-
		lence band properties
statistics	B   FD	Boltzmann (default) or Fermi-
		Dirac statistics
strain_simulation	name	the strain simulation to be used
thermal_simulation	name	the thermal simulation to be used
electron_quantum_density	name	the quantum density simulation
		to be used for the electron den-
		sity
hole_quantum_density	name	the quantum density simulation
-		to be used for the hole density

 Table 6.9:
 Common options for the drift-diffusion semiconductor models

not specified, the default semiconductor model based on bulk  $\mathbf{k} \cdot \mathbf{p}$  theory is used.

The electron\_quantum\_density and hole\_quantum\_density will use the particle densities calculated from the corresponding quantum\_density simulation. In regions where no quantum density is available, the classical density will be used. The electron\_quantum\_density and hole\_quantum\_quantum\_density keywords can be used also in the Region sections to be able to use different quantum density simulations in different regions. For further options regarding selfconsistent Schrödinger-Poisson/Drift-Diffusion calculations see Sec. 6.4.3. The strain\_simulation option is used to specify the simulation that provides strain in the case of strained systems. If it is omitted, an unstrained system is assumed for the drift-diffusion calculation.

The thermal\_simulation option is used to specify the simulation that provides the lattice temperature for non-isothermal simulations. If it is omitted, the simulation temperature as provided in the Simulation section of the input file (or, if not provided, the default value of 300 K) is used.

### 6.4.1 Simple semiconductor model

When specifying model = simple a very simple semiconductor model is used. For this model one has to provide conduction and valence band edges and the effective density of states masses in the Region sections. The corresponding keywords are given in table 6.10.

keyword	description
Ec	conduction band edge (eV)
Ev	valence band edge (eV)
m_dos_e	conduction band effective DOS mass $(m_e)$
m_dos_h	valence band effective DOS mass $(m_e)$

Table 6.10: Parameters for the simple semiconductor model

#### 6.4.2 Default semiconductor model

The default semiconductor model uses a bulk  $\mathbf{k} \cdot \mathbf{p}$  model to calculate the band parameters. It can be chosen explicitly by model = default. The model reads all needed parameters from the material data file.

The band parameters are calculated considering locally strain and lattice temperature as obtained from the corresponding simulations specified using the strain\_simulation and thermal\_simulation keywords.

#### 6.4.3 Special options for Schrödinger-Poisson calculations

TIBERCAD is able to do selfconsistent Schrödinger-Poisson or Schrödinger-Drift-Diffusion calculations. For this purpose, electron\_quantum\_density or hole\_quantum\_density has to be specified for at least one region, and a selfconsistent simulation should be defined in the Selfconsistent block. The following options – to be specified in the Physics section – control the behaviour of the selfconsistent simulation.

#### 6.5. SOLVER SECTION

use\_density\_predictor = bool When set to true, a predictor-corrector scheme will
 be adopted in the selfconsistent cycle. The Poisson/Drift-Diffusion solver does not
 just take the particle densities as given by the Schrödinger calculation, but it will
 assume a dependency of the density on the potentials of the form

$$\rho(\varphi, \phi_n, \phi_p) = \frac{\rho_{\text{quantum}}(\varphi^0, \phi_n^0, \phi_p^0)}{\rho_{\text{classical}}(\varphi^0, \phi_n^0, \phi_p^0)} \rho_{\text{classical}}(\varphi, \phi_n, \phi_p)$$
(6.13)

where  $(\varphi^0, \phi_n^0, \phi_p^0)$  are the potentials for which the quantum density was calculated. use\_density\_predictor = true is the preferred method for selfconsistent Schrödinger-Poisson/Drift-Diffusion calculations, however it is not enabled by default.

- embracing\_length = double When the domain of the quantum simulation is smaller than the domain of the full simulation, the boundary conditions for the Schrödinger equation will disturb the transfer from classical to quantum density. By defining an embracing region of a certain extension (specified in meters), a gradual transition from classical to quantum density will be done instead of an abrupt one, using as effective density  $\rho = x \cdot \rho_{\text{quantum}} + (1 - x) \cdot \rho_{\text{classical}}$ . The default is no embracing region at all (zero extension).
- cutoff = double if an embracing region is used, a part of this region near the boundary
   of the quantum region can be cut off so that only the classical density is considered
   in that part. cutoff is specified as a percentage of the embracing length and should
   therefore be between 0.0 and 1.0.
- $plot\_embracing\_regions = bool$  Whereas the automatic creation of the embracing region in 1D is a very simple task, it is a more difficult one in higher dimensions. By setting this flag to true, the embracing region and the mixing coefficient x will be plotted for a visual control of the quality of the embracing region. The default is false.

### 6.5 Solver section

Many of parameters for the numerical solver depend on the type of solver being used and on the device to be simulated. Table 6.11 lists the options that are independent on the type of solver used.

The linear and nonlinear solvers to be used can be chosen using the keywords linear\_solver and nonlinear\_solver, respectively. For the nonlinear solver one can chose between the PETSc implementation (petsc) and the TIBERCAD implementation (tiber) of line search. When using the TIBERCAD nonlinear solver, one can additionally chose between

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keyword	$description^{a}$
coupling	defines which equations to couple together.
	poisson: solve only poisson eq., electrons:
	electrons and poisson, holes: holes and pois-
	son, current: only electron and hole cur-
	rents, <full>: the fully coupled system</full>
el_qfermi_level	the spatially constant electrochemical poten-
	tial for the electrons (for quasi-equilibrium
	calculations)
hl_qfermi_level	the spatially constant electrochemical poten-
	tial for the holes (for quasi-equilibrium cal-
	culations)
integration_order	order of the numerical gauss integration. De-
	fault is 2
current_integration_method	method for the calculation of the contact
	cutrrents. surfint: integrate the local cur-
	rent density over the contact surface, <b><rsti></rsti></b> :
	use the Ramo-Snockley test functions, gives
	better results
local_scaling	apply a local scaling scheme which leads to
	better scaled matrices. <true> or faise</true>
exact_Hewton	parts in the isochian) Newton struct or
	falso
	Tatse

<sup>a</sup>the default is given in brackets

 Table 6.11:
 Solver independent parameters

the PETSc  $({\tt petsc})$  or PARDISO  $({\tt pardiso})$  linear solvers. The possible combinations are:

nonlinear\_solver = petsc

or

nonlinear\_solver = tiber linear\_solver = petsc | pardiso

### 6.5.1 Parameters for PETSc solvers

Tables 6.12 and 6.13 list all solver parameters significant for the PETSc linear and nonlinear solvers. A more detailed description of the most important parameters follows.

keyword	description	default
nonlin_rel_tol	relative tolerance for the residual $l_2$ -norm	10e-9
	(with respect to first nonlinear step)	
nonlin_abs_tol	absolute tolerance for the residual $l_2$ -norm	10e-15
nonlin_step_tol	tolerance for the $l_2$ -norm of the nonlinear	10e-3
	step	
ls_max_step	the maximum $l_2$ -norm for the line search	1
	step, in units of eV	
nonlin_max_it	maximum number of nonlinear iterations	20

Table 6.12: Parameters for the PETSc nonlinear solver

keyword	description	default
ksp_type	the linear solver type	bcgsl
pc_type	the preconditioner type	ilu
lin_rel_tol	relative tolerance for the linear solver	1e-6 <sup>a</sup>
lin_abs_tol	absolute tolerance for the linear solver	10e-50
lin_max_it	maximum number of linear iterations	500

 $^a\mathrm{The}$  linear tolerance gets automatically decreased after each nonlinear step.

 Table 6.13:
 Parameters for the PETSc linear solver

The ksp\_type specifies the type of Krylov subspace method to be used. The mostly used methods are

bcgs A stabilized version of the biconjugate gradient method. This one works better in 1D than bcgsl.

bcgsl (default) A modified version of bcgs.

gmres Generalized minimal residual method.

The  $\mathtt{pc\_type}$  specifies the type of preconditioner to be used. The most useful ones are

- ilu (default) Incomplete LU factorization. Does not work for materials with high band gap.
- jacobi Jacobi preconditioning (diagonal scaling).

composite Combination of ilu and jacobi.

The  $ls_max_step$  parameter defines an upper bound of the  $l_2$ -norm of the nonlinear line search step. It should be not too big to prevent the algorithm from diverging, but also not too small to minimize the number of iterations. Values between 1 and 10 should be a good choice.

The nonlin\_step\_tol defines at which line search step size (in  $l_2$ -norm) the algorithm stops, i.e. assumes to have reached convergence. nonlin\_step\_tol is measured in eV.

### 6.5.2 Parameters for the TIBERCAD nonlinear solver

Table 6.14 summarizes the parameters used for the TIBERCAD implementation of the line search algorithm.

keyword	description	de fault
nonlin_rel_tol	relative tolerance for the residual $l_2$ -norm	10e-9
	(with respect to first nonlinear step)	
nonlin_abs_tol	absolute tolerance for the residual $l_2$ -norm	10e-15
nonlin_step_tol	tolerance for the maximum norm of the non-	10e-3
	linear step (eV)	
nonlin_max_it	maximum number of nonlinear iterations	20

 Table 6.14:
 Parameters for the TIBERCAD line search

The stopping criterion based on the line search step uses the maximum norm of the nonlinear step, i.e. convergence is controlled locally. In addition to the parameters in table 6.14 one has to provide also parameters for the linear solver.

### 6.5.3 Parameters for the PARDISO linear solver

**NOTE:** the PARDISO linear solver is currently not included in the distribution. Currently the PARDISO interface has no adjustable parameters.

# Chapter 7

# Heat Balance simulation

The theoretical model of the heat balance problem can be found in Ref. [7].

## 7.1 Heat equation

The steady state heat equation with the continuity equation reads as

$$\nabla \cdot (-\kappa \nabla T) = H_S \tag{7.1}$$

where T is the temperature,  $\kappa$  is the thermal conductivity tensor and  $H_S$  is the total heat source. The latter term is the sum of the heat sources specified by the submodels described below. The term between the brackets represents the thermal flux  $\mathbf{J}_{\mathbf{q}}$ .

## 7.2 Physical model

By neglecting particle effects, the thermal conductivity is only due to the lattice contribution. The lattice thermal conductivity is read from the database.

The thermal model is tagged as *thermal*. In **options** subsection we indicate the simulation name (*simulation\_name = whatever\_you\_want*) and the simulation domain (*physical\_regions = wherever\_you\_want*)

```
model thermal
{
    options
    {
        simulation_name = whatever_you_want
```

```
physical_regions = wherever_you_want
}
...
}
```

### 7.2.1 Electron and hole dissipations

Electron and hole dissipations give the following heat source

$$H_S = -\nabla \cdot \left[ (P_n T + \phi_n) \mathbf{J_n} + (P_p T + \phi_p) \mathbf{J_p} \right]$$
(7.2)

where  $P_n$  and  $P_p$  are the thermoelectric power of electrons and holes, respectively.  $\phi_n$  and  $\phi_p$  are the electro-chemical potentials.

The equation 7.2 represents severals heat source contributions. Their estimates are reported in table 7.1.

Expression	Heat source
$\frac{ \mathbf{J}_{\mathbf{n}} ^2}{\sigma_n}$	Electron Joule effect
$\frac{ \mathbf{J}_{\mathbf{p}} ^2}{\sigma_{\mathbf{r}}}$	Hole Joule effect
$\vec{qR_{SRH}} \left( \phi_p - \phi_n + T \left( P_p - P_n \right) \right)$	Recombination effect
$-T\mathbf{J_n}\cdot\nabla P_n$	Electron Peltier-Thomson effect
$-T\mathbf{J}_{\mathbf{p}}\cdot\nabla P_p$	Hole Peltier-Thomson effect

Table 7.1: Drift diffusion heat sources

The physical model **heat\_source** includes a specific source identified by its **model** name. Concerning electron and hole dissipations the model is named *drift\_diffusion\_dissipation*, as reported below.

```
physical_model heat_source
{
    model = drift_diffusion_dissipation
    drift_diffusion_simulation = dd_simul_name
}
```

In order to include such a heat source we have to use a drift diffusion simulation. The syntax  $drift_diffusion_simulation = dd_simul_name$  allows this connection.

#### 7.2.2 Boundary conditions

By default, thermally insulating surfaces are considered, i.e.

$$\mathbf{J}_{\mathbf{q}} \cdot \mathbf{N} = 0 \tag{7.3}$$

On the opposite side it is possible to include an ideal thermally conducting interface by fixing the temperature to the external one, i.e. :

$$T = T_{ext} \tag{7.4}$$

This condition can be imposed with the following notation

```
BC_Regions
{
   BC_Region name_BC_region
   {
    type = heat_reservoir
    BC_reg_numb = 3
    temperature = 300
   }
}
```

Once a BC\_Region is inserted in the thermal section, heat\_reservoir is the default type. The default temperature is the one indicated in the solve section.

Between such extreme situations, it is possible to take into account a thermally resistive interface, i.e.

$$\mathbf{J}_{\mathbf{q}} \cdot \mathbf{N} = G_s(T - T_{ext}) \tag{7.5}$$

where  $G_s$  is the thermal surface conductance and  $T_{ext}$  is the external temperature. One can include this condition with the BC type **thermal\_surface\_conductance**:

```
BC_Regions
{
   BC_Region name_BC_region
   {
    type = thermal_surface_conductance
    BC_reg_numb = 3
    g_surf = 0.01
    temperature = 300
   }
}
```

where  $g\_surf$  indicates  $G_s$  and temperature stands for  $T_{ext}$ .

Alternatively, it is possible to indicate the  $R_s = 1/G_s$  quantity i.e. the thermal surface resistance. The notation is

```
BC_Regions
{
   BC_Region name_BC_region
   {
     type = thermal_surface_resistance
     BC_reg_numb = 3
     r_surf = 100
     temperature = 300
   }
}
```

Furthermore, it is possibile to fix the normal thermal power density to a given value  $J_{ext}$ , i.e.

$$\mathbf{J}_{\mathbf{q}} \cdot \mathbf{N} = J_{ext} \tag{7.6}$$

This condition is set with the BC type **thermal\_flux**:

```
BC_Regions
{
    BC_Region name_BC_region
    {
      type = thermal_flux
      BC_reg_numb = 3
      power_density = 100
    }
}
```

## 7.3 Output data

The variable labels are listed in the tables 7.3-7.5.

It is also possible to identify all heat sources with the keyword HeatSource and all power fluxes with PowerFlux. Finally, with the keyword thermal all quantities concerning the thermal simulation will be stored.

#### 7.3. OUTPUT DATA

description	type	parameters	units
Ideal insulating interface	(Default)	(No parameters)	
Ideal conducting interface	heat_reservoir	temperature	K
Resistive interface	thermal_surface_resistance	temperature	K
		r_surf	$cm^2KW^{-1}$
Resistive interface	thermal_surface_conductance	temperature	
		g_surf	$WK^{-1}cm^{-2}$
Power density condition	thermal_flux	power_density	$Wcm^{-2}$

 Table 7.2:
 Thermal boundary conditions

Nodal scalar quantities

LatticeTemp | Temperature | K

 Table 7.3:
 Nodal scalar quantities

### Elemental scalar quantities

eJoule	Electron Joule effect	$Wcm^{-3}$
hJoule	Hole Joule effect	$W cm^{-3}$
RecHeat	Recombination heat	$W cm^{-3}$
ePelTh	Electron Peltier-Thomson effect	$W cm^{-3}$
hPelTh	Hole Peltier-Thomson effect	$W cm^{-3}$
TotalHeat	TotalHeat	$W cm^{-3}$
LatticeThermalCond	Lattice thermal conductivity	$Wcm^{-1}K^{-1}$

 Table 7.4:
 Elemental scalar quantities

### Elemental vector quantities

	-	
Wq	Thermal flux	$W cm^{-2}$
Wn	Electron power flux	$W cm^{-2}$
Wp	Hole power flux	$W cm^{-2}$
W	Total power flux	$W cm^{-2}$

 Table 7.5:
 Elemental vector quantities

## Chapter 8

# **Envelope Function Approximation**

The envelope function appriximation (EFA) simulation tool of TIBERCAD is developed in order to solve a single-particle Schrödinger equation for electrons and holes in a semiconductor crystal. This problem is an eigenvalue problem that is treated as a generalized complex eigenvalue problem

$$H\psi = S\psi,\tag{8.1}$$

where H and S are the Hamiltonian and S-matrix, respectively.

## 8.1 Models section parameters

The **Models** section looks like follows:

```
model efaschroedinger
{
    options
    {
        simulation_name = quantum_well1
        physical_regions = (1,2)
    }
}
```

The default boundary conditions of the simulation domain are open (that is zero flux for single-band calculation). It is possible to specify Dirichlet boundary conditions:

```
BC_Region infinite_barrier1
{
    BC_reg_numb = 12
```

```
type = Dirichlet
```

}

There is a way to impose automatically the Dirichlet boundary conditions over all the boundary of the simulation region. This is done by the parameter

 $Dirichlet_bc_everywhere = \{true | false\} in Solver section. The default value for EFA problem is true.$ 

## 8.2 Solver parameters

There are two groups of parameters. The first group is related to the general eigensolver problem, the second one is related to the Schrödinger equation.

### 8.2.1 Eigenvalue problem parameters

These parameters are common for all eigenvalue problems. Their default values may be different for different eigenvalue problems, for example for the Schroedinger equation and for the electromagnetic eigenvalue problem.

The eigenvalue problem can be solved by the solvers that are implemented into the SLEPc library. The relative parameter is

solver = { arnoldi | lapack | krylovshur }. The default value is krylovshur.

In the case of the lapack solver all the eigenvalues are computed. In the case of arnoldi or krylovshur solver it is necessary to specify which and how many eigenvalues have to be computed. The idea is that the iterative solver calculates several eigenvalues that a close to a specific number, reffered to as the *spectral\_shift*. The relative parameters are:

max_iteration_number	maximum number of iteration, used as a stop condition
eigen_solver_tolerance	numerical eigensolver tolerance used as a convergence criteria
spectral_shift	the closest eigenvalues to this value (eV) are found.
spectrum_inversion_tolerance	tolerance used for linear solver

 Table 8.1: Iterative eigensolver parameters

If the spectral\_shift is not defined then it will be calculated internally from the band edges.

For the iterative solvers the important parameters, that may significantly change the performance, are the *Krylov subspace method* type and the *preconditioner* type.

The Krylov method is defined as follows:

 $ksp\_type = \{ bcgsl \mid gmres \mid bcgs \mid cg \mid richardson \mid preonly \}$ 

#### 8.3. PHYSICAL MODELS PARAMETERS

The **preconditioner** type is defined as follows:  $pc\_type = \{ \text{ cholesky } | \text{ jacobi } | \text{ ilu } | \text{ composite } \}$ 

Other options:

- x-periodicity = { true | false}
- y-periodicity = { true | false}
- z-periodicity = { true | false}
- *number\_of\_eigenstates* = number of eigenstates to be computed

### 8.2.2 Schrödinger equation parameters

- *particle* = { el | hl }; specifies a particle type, according to each the eigenvalues are sorted
- *strain\_model\_name* = name of the simulation that can provide elastic strain
- *poisson\_model\_name* = name of the simulation that can provide electric and electrochemical potential
- *heat\_model* = name of the simulation that can provide
- *relative\_density\_tolerance* = relative tolerance for charge density calculation
- *initial\_eigenstates\_number* = initial eigenstates number for charge density calculation
- convergent\_density = { true | false } if true than number of eigenstates will be increased in oder to reach convergent density.
- *eigen\_number\_increase\_factor* = factor to increase eigenvalues number for the next charge density calculation

## 8.3 Physical Models parameters

- $particle = \{ el \mid hl \}$
- $model = \{ \text{ conduction\_band } | \text{ kp } \} \text{ single conduction band } (\Gamma \text{ point}) \text{ or } \mathbf{k} \cdot \mathbf{p}.$
- $kp\_model = \{ 6 \times 6 \mid 8 \times 8 \}$

Here, the *particle* name is the name of a particle type (*electron* or *hole*).  $model = \mathbf{kp} \mid \mathbf{conduction\_band} : \mathbf{k} \cdot \mathbf{p}$  or single conduction band model. If  $\mathbf{k} \cdot \mathbf{p}$  model is applied, specify:  $kp\_model = \mathbf{6x6} \mid \mathbf{8x8}$ .

## 8.4 Output

- **EigenEnergy** Eigen energy in eV
- EigenFunctions  $|\psi(\mathbf{r})|^2$  function of the eigenstate
- **Occupation** probability to find the state occupied. It is calculated assuming Fermi distribution and mean electrochemical potential and temperature:

$$\bar{\mu} = \langle \psi | \mu(\mathbf{r}) | \psi \rangle \tag{8.2}$$

$$\bar{T} = \langle \psi | T(\mathbf{r}) | \psi \rangle \tag{8.3}$$

• EnergyLevels graphical output used for showing the energy level over the band diagram

# Chapter 9

# Simulation opticskp

By defining the **opticskp** model, calculation of optical properties is enabled; in particular, the optical kp matrix elements are calculated from the quantum models specified in **Solver** section:

```
opticskp
{
    initial_state_model = QW1_electrons # quantum_el
    final_state_model = QW1_holes # quantum_hl
    initial_eigenstates = (0, 19)
    final_eigenstates = (0, 19)
}
```

Here, *initial\_state\_model* and *final\_state\_model* are, respectively, the quantum models (**efaschroedinger** model) associated respectively to the initial state of optical transition (e.g. electron), and to the final state of optical transition (e.g. hole). *initial\_eigenstates* and *final\_eigenstates* refer to the range of eigenstates to be taken in account for optical calculations. By specifying, in **Solver** section, a range of energy values in this way:

```
Emin = 3.0
Emax = 5.0
dE = 0.001
```

the emission optical spectrum for  $\mathbf{k}=0$  is calculated. The spectrum is calculated in the following way:

$$P(\hbar\omega) = \sum_{i,j} \frac{1}{2\pi^2} \frac{\omega_{ij}^2 e^2}{m^2 c^3} |\mathbf{M}_{i,j}\mathbf{e}|^2 f_i(E_i) (1 - f_j(E_j)) \frac{\Gamma/2}{(\hbar\omega_{ij} - \hbar\omega)^2 + (\Gamma/2)^2} d\Omega, \qquad (9.1)$$

where  $f_i$  and  $f_j$  are the Fermi distributions.

## 9.1 Output

The output variables for optics calculations are:

 $\bullet$  optical\_spectrum\_k\_0 : optical emission spectrum for k=0, calculated through optics kp model

# Chapter 10

# Simulation optical spectrum

By defining the model **opticalspectrum**, optical matrix elements are used to calculate the associated (emission) spectrum with a k-space integration. In **Solver** section:

```
opticalspectrum
{
   k_space_dimension = 2
   k-space_basis = true
   k1 = (0, 0, 0.1)
   k2 = (0, 0.1, 0)
   refine_fraction = 0.30
   relative_accuracy = 0.01
   refine_k_space = true
   number_of_nodes = (2, 2)
    wedge = quarter
    optical_matr_elem_model = opticskp
   polarization = (0, 0, 1)
   Emin = 3.0
   Emax = 5.0
   dE = 0.001
}
```

The parameters:

 $k\_space\_dimension = 1$  for 2D simulations, 2 for 1D simulations.  $k\_space\_basis$  is true if the k-space is defined by means of k-vectors; if false, vectors are expressed in real space

If  $refine\_k\_space = true$ , that is adaptive k-mesh refinement is enabled, all the elements whose error is greater than the value  $(1-refine\_fraction)^*$  (maximum error) are going to be refined. In this case, 'Error' is just the integrated quantity. The refinement will end when the *relative\\_accuracy* is obtained.

 $number_of_nodes = numb.$  of elements in k mesh, along each direction wedge = half | quarter, to reduce calculation time, by exploiting symmetry.  $optical_matr_elem_model = name of the opticskp model associated$  polarization = light polarization (vector)Emin, Emax, dE : energy range and step of spectrum calculation.

## 10.1 Output

The output variables for optics calculations are:

• optical\_spectrum: k-space integrated optical emission spectrum, calculated by opticalspectrum model

# Chapter 11

# Quantum dispersion

There is a possibility to calculate the dependence of quantum eigenstates on k-vector. Such dependence is called *dispersion*. The simulation name is **quantum dispersion**. Example:

```
model quantumdispersion
{
    options
    {
        simulation_name = dispersion1D_el
        physical_regions = all
    }
}
```

## 11.1 Solver options

The dispersion of quantum states is calculate at k-points that are nodes of the mesh in k-space.

- quantum\_simulation name of the Schrödinger equation simulation
- min\_eigenvalue\_number, max\_eigenvalue\_number: the dispersion is calculated for the states number i, where

 $max\_eigenvalue\_number \geq i \geq min\_eigenvalue\_number$ 

The rest of the parameters (wedge, k\_space\_dimension, etc...) define the k-space

```
dispersion1D_el
{
   quantum_simulation = quantum_el
   min_eigenvalue_number = 0
   max_eigenvalue_number = 5
   wedge = half
   k_space_dimension = 1
   k1 = (0, 0.1, 0)
   number_of_nodes = (10)
   output_format = grace
}
```

## 11.2 Output

The output variable name is **k-space\_dispersion**. The output format for the dispersion can be controlled independently of the general specification in the **Simulation** section by redefining the **output\_format** keyword.

# Chapter 12

# Quantum Density

```
dens_el
{
    k_{space_dimension} = 2
   k-space_basis = true
   k1 = (0, 0, 0.1)
   k2 = (0, 0.1, 0)
    number_of_nodes = (4, 4)
    wedge = quarter
    refine_fraction = 0.20
    relative_accuracy = 0.01
    refine_k_space = true
    uniform_refinement = false
    mesh_order = FIRST
    quantum_simulation = quantum_el
    degeneracy = 2
    initial_eigenstates_number = 10
    analitic = false
}
```

- quantum\_simulation name of the Schrödinger simulation
- **degeneracy** degeneracy of the quantum state
- initial\_eigenstates\_number initial number of eigenstates for the Schrödinger equation
- analytic = { true | false } If true then the density is calculated analytically or numerically

Analitcal calculation of density is done in the following way. For each eigenstate we calculate the effective mass assuming quadratic dispersion. Then the charge density is calculate as follows:

$$\rho_{1D}(\mathbf{r}) = g \frac{mkT}{2\pi\hbar^2} |\psi(\mathbf{r})|^2 \ln\left(1 + \exp\left(\pm\frac{\mu - E}{kT}\right)\right)$$
(12.1)

$$\rho_{2D}(\mathbf{r}) = g|\psi(\mathbf{r})|^2 \frac{1}{2} \sqrt{\left(\frac{mkT}{2\pi\hbar^2}\right)} F_{-1/2}\left(\pm\frac{\mu-E}{kT}\right),\tag{12.2}$$

where  $\rho_{1D}$  and  $\rho_{2D}$  are the 1D and 2D charge densities; *m* is the averaged mass (the mass is different for each quantized state and is position independent); *g* is the degeneracy of the states. The + sign is for electrons, the - sign is for holes.

Numerical calculation is done by the following formula:

$$\rho(\mathbf{r}) = \sum_{n} \frac{1}{(2\pi)^d} \int_{BZ} |\psi(\mathbf{r})|^2 \frac{1}{1 + \exp\left(\pm\frac{E-\mu}{kT}\right)} d\mathbf{k}_{\parallel}$$
(12.3)

The integration is performed on a mesh in the k-space.

## 12.1 Output

The output parameter is **quantum\_density**.

# Bibliography

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